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# **DEFENSE LOGISTICS AGENCY**

DEFENSE SUPPLY CENTER, COLUMBUS POST OFFICE BOX 3990 COLUMBUS, OH 43218-3990

DATE 17 September 2004

# MEMORANDUM FOR MILITARY/INDUSTRY DISTRIBUTION

SUBJECT: Initial Draft of MIL-PRF-38510/103, Revision G; Project Number 5962-2083

The initial draft for this subject document, dated 17 September 2004, is now available for viewing and downloading from the DSCC-VA Web site:

http://www.dscc.dla.mil/Programs/MilSpec/DocSearch.asp

Major changes to this document include adding case outline letter "Z" (10 lead flat pack with gull wing leads). Paragraphs have been changed to meet current requirements of MIL-STD-961. Burn-in circuits have been deleted and replaced by a statement requiring the circuits to be maintained by the manufacturer under document control. The slash sheet is being updated to reflect current requirements.

Concurrence or comments are required at this Center within 45 days from the date of this letter. Late comments will be held for the next coordination of the document. Comments from military departments must be identified as either "Essential" or "Suggested". Essential comments must be justified with supporting data. Military review activities should forward comments to their custodians of this office, as applicable, in sufficient time to allow for consolidating the department reply.

The point of contact for this document is Mr. Rick Officer, Defense Supply Center Columbus, DSCC-VAS, Post Office Box 3990, Columbus, OH 43218-3990. Mr. Officer can also be reached at 614-692-0518/850-0518, or by facsimile 614-692-6939/850-6939, or by e-mail to: rick.officer@dla.mil.

RAYMOND MONNIN Chief MicroelectronicsTeam

cc: VSS CAAB NOTE: This draft, dated 17 September 2004 prepared by Defense Supply Center Columbus (DSCC-VAS) has not been approved and is subject to modification.

DO NOT USE PRIOR TO APPROVAL. ( Project 5962-2083 )

INCH-POUND
MIL-M-38510/103G
DRAFT
SUPERSEDING
MIL-M-38510/103F
28 October 2003

### MILITARY SPECIFICATION

### MICROCIRCUITS, LINEAR, VOLTAGE COMPARATORS, MONOLITHIC SILICON

Inactive for new design after 13 July 1995

This specification is approved for use by all Departments and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF-38535.

- 1. SCOPE
- 1.1 <u>Scope</u>. This specification covers the detail requirements for monolithic silicon, voltage comparators. Two product assurance classes and a choice of case outlines and lead finish are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3).
  - 1.2 Part or Identifying Number (PIN). The PIN is in accordance with MIL-PRF-38535, and as specified herein.
  - 1.2.1 Device types. The device types are as shown in the following:

Device type	Circuit
01	Single differential voltage comparator
02	Dual channel differential voltage comparator
03	Single differential voltage comparator / buffer
04	Precision voltage comparator / buffer
05	Dual precision voltage comparator / buffer 1/
06	Dual precision high speed voltage comparator
07	Dual high precision, high speed voltage comparator

1.2.2 Device class. The device class is the product assurance level as defined in MIL-PRF-38535.

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, 3990 East Broad St., Columbus, OH 43218-3990, or email linear@dscc.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at www.dodssp.daps.mil.

AMSC N/A FSC 5962

<sup>1/</sup> Device type 05 may be monolithic, or it may consist of two separate, independent dice.

### 1.2.3 Case outlines. The case outlines are designated in MIL-STD-1835 and as follows:

Outline letter	<u>Descriptive designator</u>	<u>Terminals</u>	Package style
A 2/	GDFP5-F14 or CDFP6-F14	14	Flat pack
C _	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
Е	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat pack
G	MACY1-X8	8	Can
Н	GDFP1-F10 or CDFP2-F10	10	Flat pack
I	MACY1-X10	10	Can
Р	GDIP1-T8 or CDIP2-T8	8	Dual-in-line
X	CDFP4-T16	16	Flat pack
Z	GDFP1-G10	10	Flat pack with gull wing leads
2	CQCC1-N20	20	Square leadless chip carrier

# 1.3 Absolute maximum ratings.

			Device type	oes	
	01	02	03	04 and 05	06 and 07
Positive supply voltage	+14.0 V	+14.0 V	+15.0 V	+30.0 V	+18 V
Negative supply voltage	-7.0 V	-7.0 V	-15.0 V	-30.0 V	-25 V
Total supply voltage				+36.0 V	+36 V
Output voltage			+24.0 V		
Output to negative supply voltage			+30.0 V	+50.0 V	+36.0 V
Input voltage range	±7.0 V	±7.0 V	±7.0 V	<u>3</u> /	±15.0 V <u>4</u> /
Differential input voltage	±5.0 V	±5.0 V	±5.0 V	±30.0 V	±5.0 V
Peak output current	10 mA	50 mA			25 mA
Sink current			100 mA	50 mA	
Output short-circuit duration	10 s	10 s	10 s	10 s	10 s
Strobe voltage		6.0 V	6.0 V		
Maximum strobe current				10 mA	
Storage temperature range	-65°C to -	+150°C for a	II device types	3	
Junction temperature (T <sub>J</sub> ) <u>5</u> /	+175°C	+175°C	+175°C	+175°C	+175°C
Lead temperature (soldering, 60 seconds)	+300°C	+300°C	+300°C	+300°C	+300°C

# 1.4 Recommended operating conditions.

<sup>2/</sup> Inactive case outline.

<sup>3/</sup> The positive input voltage limit is 30 V above the negative supply. The negative input voltage limit is equal to the negative supply voltage or 30 V below the positive supply, whichever is less negative.

<sup>4/</sup> For supply voltages less than ±15.0 V dc, the input voltage rating is equal to the supply voltage.

<sup>5/</sup> For short term test (in the specific burn-in and life test configuration when required and up to 168 hours maximum) T<sub>J</sub> = +275°C.

### 1.5 Power and thermal characteristics.

Case outlines	Maximum allowable power	Maximum	Maximum
	dissipation	θЈС	$\theta_{\sf JA}$
Α	350 mW at T <sub>A</sub> = +125°C	60°C/W	140°C/W
C, E, and P	400 mW at T <sub>A</sub> = +125°C	35°C/W	120°C/W
G	330 mW at T <sub>A</sub> = +125°C	40°C/W	150°C/W
I	350 mW at T <sub>A</sub> = +125°C	40°C/W	140°C/W
Н	330 mW at T <sub>A</sub> = +125°C	60°C/W	150°C/W
F	350 mW at T <sub>A</sub> = +125°C	60°C/W	140°C/W
Х	200 mW at T <sub>A</sub> = +125°C	35°C/W	140°C/W
Z	330 mW at T <sub>A</sub> = +125°C	21°C/W	225°C/W still air
			142°C/W 500 LFPM
2	199 mW at T <sub>A</sub> = +125°C	55°C/W	121°C/W

### 2. APPLICABLE DOCUMENTS

2.1 <u>General</u>. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

### 2.2 Government documents.

2.2.1 <u>Specifications, standards, and handbooks</u>. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

### DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

### **DEPARTMENT OF DEFENSE STANDARDS**

MIL-STD-883 - Test Method Standard for Microelectronics.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

(Copies of these documents are available online at <a href="http://assist.daps.dla.mil/quicksearch/">http://assist.daps.dla.mil/quicksearch/</a> or <a href="www.dodssp.daps.mil">www.dodssp.daps.mil</a> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.

2.3 <u>Order of precedence</u>. In the event of a conflict between the text of this specification and the references cited herein the text of this document shall take precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

### 3. REQUIREMENTS

- 3.1 Qualification. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).
- 3.2 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.
- 3.3 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.
  - 3.3.1 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.3.2 <u>Schematic circuits</u>. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity (DSCC-VA) upon request.
  - 3.3.3 Case outlines. The case outlines shall be as specified in 1.2.3.
  - 3.4 Lead material and finish. Lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).
- 3.5 <u>Electrical performance characteristics</u>. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full operating ambient temperature range of -55°C to +125°C.
  - 3.6 Rebonding. Rebonding shall be in accordance with MIL-PRF-38535.
- 3.7 <u>Electrical test requirements</u>. Electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.
  - 3.8 Marking. Marking shall be in accordance with MIL-PRF-38535.
- 3.9 <u>Microcircuit group assignment</u>. The devices covered by this specification shall be in microcircuit group number 50 (see MIL-PRF-38535, appendix A).

TABLE I. <u>Electrical performance characteristics</u>.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Input offset voltage	V <sub>IO</sub>	V <sub>OUT</sub> = 1.4 V,	1	01	-2	+2	mV
		$R_S$ = 200 $\Omega$ and 50 $\Omega$		02	-3.5	+3.5	
		V <sub>OUT</sub> = 1.0 V,	2	01	-3	+3	
		$R_S$ = 200 $\Omega$ and 50 $\Omega$		02	-4.5	+4.5	
		V <sub>OUT</sub> = 1.8 V,	3	01	-3	+3	
		Rs = 200 $\Omega$ and 50 $\Omega$		02	-4.5	+4.5	
		V <sub>OUT</sub> = 1.5 V,	1	03	-2	+2	
		$R_S$ = 200 $\Omega$ and 50 $\Omega$	2,3		-3	+3	
		V <sub>IC</sub> = 0 V, 13 V and <u>3/</u> -14.5 V,	1	04,05	-3	+3	
		$R_S = 50 \Omega$ ,	2,3		-4	+4	
		±V <sub>CC</sub> = ±2.5 V,	1		-3	+3	
		$R_S = 50 \Omega$ , $V_{IC} = 0 V$	2,3		-4	+4	-
		V <sub>IC</sub> = 0 V, +12 V, and <u>3</u> / -12 V,	1	06	-4	+4	
		$R_S = 50 \Omega$	2,3		-7	+7	
			1	07	-1	+1	
			2,3		-2	+2	

 ${\sf TABLE\ I.\ } \underline{\sf Electrical\ performance\ characteristics} - Continued.$ 

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Input offset voltage	V <sub>IO</sub>	+V <sub>CC</sub> = 5 V, -V <sub>CC</sub> = 0 V	1	06	-4	+4	mV
		$R_S = 50 \Omega$ , $V_{IC} = 2.5 V$	2,3		-7	+7	
			1	07	-1	+1	
			2,3		-2	+2	
Raised input offset 4/ voltage	V <sub>IO(R)</sub>	$V_{IC} = 0 \text{ V}, 13 \text{ V}, \text{ and } \underline{3}/$ -14.5 V, $R_S = 50 \Omega$ ,	1	04,05	-3	+3	mV
		VBAL = VBAL / STB = +VCC	2,3		-4.5	+4.5	
Input offset voltage temperature coefficient	ΔV <sub>IO</sub> / ΔT	$R_S = 50 \Omega$	2,3	01,02, 03	-10	+10	μV/°C
				04,05	-25	+25	
Input offset current	lio	V <sub>OUT</sub> = 1.4 V	1	01	-3	+3	μΑ
				02	-10	+10	
		V <sub>OUT</sub> = 1.0 V	2	01	-3	+3	
				02	-10	+10	
		V <sub>OUT</sub> = 1.8 V	3	01	-7	+7	
				02	-20	+20	
		V <sub>OUT</sub> = 1.5 V	1,2	03	-3	+3	
			3		-7	+7	

 ${\sf TABLE\ I.\ } \ \underline{\sf Electrical\ performance\ characteristics} - Continued.$ 

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type			Unit
					Min	Max	
Input offset current	lio	$V_{IC} = 0 \text{ V}, 13 \text{ V}, \text{ and } \underline{3}/$ -14.5 V,	1,2	04,05	-10	+10	nA
	$R_S = 50 \text{ k}\Omega$	$R_S = 50 \text{ k}\Omega$	3		-20	+20	
		$V_{IC} = 0 \text{ V}, +12 \text{ V}, \text{ and } \underline{3}/$ -12 V,	1,2	06	-75	+75	
				07	-40	+40	
			3	06	-100	+100	
				07	-75	+75	
Raised input offset 4/	I <sub>IO(R)</sub>	$V_{IC} = 0 \text{ V}, \text{ Rs} = 50 \text{ k}\Omega,$	1,2	04,05	-25	+25	nA
		V <sub>BAL</sub> = V <sub>BAL</sub> / STB = +V <sub>CC</sub>	3		-50	+50	
Input offset current temperature coefficient	ΔI <sub>IO</sub> / ΔΤ	T <sub>A</sub> = +125°C	2	01,02, 03	-25	+25	nA/°C
		$R_S = 50 \text{ k}\Omega$ , $T_A = +125^{\circ}\text{C}$		04,05	-100	+100	pA/°C
		$T_{A} = -55^{\circ}C$	3	01,02, 03	-75	+75	nA/°C
		$R_S = 50 \text{ k}\Omega$ , $T_A = -55^{\circ}\text{C}$		04,05	-200	+200	pA/°C
Input bias current	+I <sub>IB</sub>	TA = -33 C	1,2	01,03	-0.1	+20	μΑ
				02	-0.1	+75	
			3	01,03	-0.1	+45	
				02	-0.1	+150	

TABLE I. <u>Electrical performance characteristics</u> – Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A Device subgroups type		Limits		Unit
					Min	Max	
Input bias current	+l <sub>IB</sub>	$V_{IC} = 0 \text{ V}, \text{ R}_{S} = 50 \text{ k}\Omega$	1,2	04,05	-100	+0.1	nA
			3		-150	+0.1	
		V <sub>IC</sub> = 13 V and –14.5 V,	1,2		-150	+0.1	
		$R_S = 50 \text{ k}\Omega$	3		-200	+0.1	
		V <sub>IC</sub> = 0 V	1,2	06,07	-0.1	+500	
			3	-	-0.1	1000	
		V <sub>IC</sub> = +12 V and –12 V	1,2	-	-0.1	+750	
			3	-	-0.1	+1000	
	-I <sub>IB</sub>	$V_{IC} = 0 \text{ V}, \text{ Rs} = 50 \text{ k}\Omega$	1,2	04,05	-100	+0.1	
			3		-150	+0.1	
		V <sub>IC</sub> = 13 V and –14.5 V,	1,2		-150	+0.1	-
		$R_S = 50 \text{ k}\Omega$	3		-200 +0.	+0.1	
		V <sub>IC</sub> = 0 V	1,2	06,07	-0.1	+500	
			3		-0.1	+1000	
		V <sub>IC</sub> = +12 V and -12 V	1,2		-0.1	+750	
			3		-0.1	+1000	

TABLE I. <u>Electrical performance characteristics</u> – Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Strobe current	ISTROBE	$V_{STROBE} = 100 \text{ mV},$ $V_{ID} = +10 \text{ mV}$	1,2,3	02	-2.5	-0.1	mA
		VSTROBE = 400 mV, V <sub>ID</sub> = -5 mV		03	-3.3	-0.1	
Strobed output level	V <sub>O</sub> (strobed)	V <sub>STROBE</sub> = 0.3 V, <u>5</u> / V <sub>ID</sub> = +10 mV	1,2,3	02	-1.0	0	V
		VSTROBE = 0.9 V, V <sub>ID</sub> = -5 mV		03	+2.5	+5.5	
		VSTROBE = 2.5 V, V <sub>ID</sub> = -5 mV, I <sub>OL</sub> = 16 mA				+0.4	
Collector output voltage (strobed)	V <sub>O(STB)</sub>	$I_{STB} = -3.0 \text{ mA}$ $R_S = 50 \Omega$	1,2,3	04,05	+14		V
Input voltage common mode rejection	CMR	$-V_{CC} = -7.0 \text{ V}, \text{ R}_{S} = 200 \Omega,$ -5 V ≤ V <sub>IN</sub> ≤ +5 V	1,2,3	01,02, 03	+80		dB
Common mode rejection ratio	CMRR	$V_{IC}$ = 13 V and -14.5 V, $R_S$ = 50 $\Omega$	1,2,3	04,05	+80		dB
		$V_{IC}$ = +12 V and -12 V, $R_S$ = 50 $\Omega$		06,07	90		
High level output voltage	VoH	V <sub>ID</sub> = +5 mV, I <sub>OH</sub> = 0 mA	1,2,3	01	+2.5	+5.0	V
•		V <sub>ID</sub> = +10 mV, I <sub>OH</sub> = 0 mA		02	+2.5	+5.0	
		V <sub>ID</sub> = +5 mV, I <sub>OH</sub> = -5 mA		01	+2.5	+5.0	
		V <sub>ID</sub> = +10 mV, I <sub>OH</sub> = -5 mA		02	+2.5	+5.0	
		V <sub>ID</sub> = +5 mV,		03	+2.5	+5.5	
		Ι <sub>ΟΗ</sub> = -400 μΑ					

TABLE I. <u>Electrical performance characteristics</u> – Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Low level output voltage	V <sub>OL</sub>	$V_{ID} = -5 \text{ mV}, I_{OL} = 0 \text{ mA}$	1,2,3	01	-1.0	0	V
		$V_{ID}$ = -10 mV, $I_{OL}$ = 0 mA		02	-1.0	0	
		V <sub>ID</sub> = -5 mV, I <sub>OL</sub> = 100 mA	1	03		+1.5	
		V <sub>ID</sub> = -5 mV, I <sub>OL</sub> = 16 mA	2			+0.4	
		V <sub>ID</sub> = -5 mV, I <sub>OL</sub> = 50 mA	3			+1.0	
	V <sub>OL1</sub>	$+V_{CC} = +4.5 \text{ V}, -V_{CC} = 0 \text{ V},$ $V_{IC} = -1.75 \text{ V}, +0.75 \text{ V},$ $V_{ID} = -6.0 \text{ mV}, I_{O} = 8 \text{ mA}$	1,2,3	04,05		+0.4	
	V <sub>OL3</sub> V <sub>OL4</sub>	$\pm V_{CC} = \pm 15 \text{ V},$ $V_{IC} = 13 \text{ V}, -14 \text{ V},$ $V_{ID} = -5.0 \text{ mV}, I_{O} = 50 \text{ mA}$				+1.5	-
	V <sub>OL1</sub>	+V <sub>CC</sub> = +4.5 V, -V <sub>CC</sub> = 0 V, V <sub>IC</sub> = +2.25 V, +1.0 V,	1,2	06,07		+0.4	
	, OLZ	$V_{ID} = 7.0 \text{ mV}, I_{O} = 3.2 \text{ mA}$	3	-		+0.6	
	V <sub>OL3</sub>	$V_{IC} = \pm 12 \text{ V},$ $V_{ID} = -7.0 \text{ mV}, I_{O} = 25 \text{ mA}$	1,2,3			+1.5	
Output sink current	IOL	V <sub>ID</sub> = -5.0 mV, V <sub>OL</sub> = 0 V	1	01	+2.0		mA
		V <sub>ID</sub> = -10 mV, V <sub>OL</sub> = 0 V	-	02	+0.5		1
		V <sub>ID</sub> = -5.0 mV, V <sub>OL</sub> = 0 V	2	01	+0.5		
		V <sub>ID</sub> = -10 mV, V <sub>OL</sub> = 0 V	-	02	+0.12		1

TABLE I. <u>Electrical performance characteristics</u> – Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Output sink current	l <sub>OL</sub>	$V_{ID} = -5.0 \text{ mV}, V_{OL} = 0 \text{ V}$	3	01	+1.0		mA
		V <sub>ID</sub> = -10 mV, V <sub>OL</sub> = 0 V		02	+0.25		
Output leakage current	ICEX	V <sub>OUT</sub> = 24 V, V <sub>ID</sub> = +5 mV	1	03	-0.1	+1.0	μА
			2,3		-0.5	+100	
		±V <sub>CC</sub> = ±18 V,	1	04,05	-1	+10	nA
		V <sub>OUT</sub> = 32 V	2	-	-1	+500	
		±V <sub>CC</sub> = ±18 V,	1	06,07	-1	+2.0	μΑ
		V <sub>O</sub> = 18 V	2		-1	+10.0	
Input leakage current	I <sub>I1</sub>	$\pm V_{CC} = \pm 18 \text{ V}, V_{ID} = +29 \text{ V}$	1,2,3	04,05	-5	+500	nA
	I <sub>I2</sub>	$\pm V_{CC} = \pm 18 \text{ V}, V_{ID} = -29 \text{ V}$			-5	+500	
Positive supply current	+I <sub>CC</sub>	V <sub>ID</sub> = -5 mV, V <sub>OUT</sub> = V <sub>OL</sub>	1,2,3	01	+0.5	+9.0	mA
		V <sub>ID</sub> = -10 mV, V <sub>OUT</sub> = V <sub>OL</sub>		02	+0.5	+13.5	
		V <sub>ID</sub> = -5 mV	1	03	+0.5	+10	
		Limit is for one comparator of device type 05	1,2	04,05		+6.0	
			3			+7.0	
			1,2	06,07		+10.0	
			3	-		+11.5	

TABLE I. <u>Electrical performance characteristics</u> – Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Negative supply current	-I <sub>CC</sub>	$V_{ID} = -5 \text{ mV}, V_{OUT} = V_{OL},$ no load	1,2,3	01	-7.0	-0.5	mA
		$V_{ID} = -10 \text{ mV}, V_{OUT} = V_{OL},$ no load		02	-6.2	-0.5	
		V <sub>ID</sub> = -5 mV		03	-3.6	-0.5	
		Limit is for one comparator of device type 05	1,2	04,05	-5.0		-
			3		-6.0		
			1	06,07	-5.0		-
			2		-4.5		-
			3		-6.0		
Output short-circuit current	Ios	10 ms maximum test duration	1	04,05		+200	mA
			2			+150	
			3			+250	
Adjustment for input offset voltage	V <sub>IO(ADJ)+</sub>	R <sub>S</sub> = 50 Ω	1	04,05	+5.0		mV
	V <sub>IO(ADJ)</sub> -					-5.0	
Voltage gain	A <sub>V</sub> (±)	$\Delta V_{OUT} = \pm 0.5 \text{ V},$	4	01	+1,250		V/V
		V <sub>OUT</sub> = 1.4 V		02	+750		
		$\Delta V_{OUT} = \pm 0.5 \text{ V},$	5	01	+1,000		
		V <sub>OUT</sub> = 1.0 V		02	+500		

 ${\sf TABLE\ I.\ } \underline{\sf Electrical\ performance\ characteristics} - Continued.$ 

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Lin	nits	Unit
					Min	Max	
Voltage gain	A <sub>V</sub> (±)	$\Delta V_{OUT} = \pm 0.5 V$ ,	6	01	+1,000		V/V
		V <sub>OUT</sub> = 1.8 V		02	+500		
Voltage gain	A <sub>V</sub> +	$\Delta V_{OUT} = 3.0 \text{ V},$	4	03	+30		V/mV
		V <sub>OUT</sub> = 1.5 V	5		+10		
			6		+50		
Voltage gain	A <sub>V</sub> -	$\Delta V_{OUT} = -1.0 V,$	4	03	+30		V/mV
		V <sub>OUT</sub> = 1.5 V	5		+10		
			6	-	+50		
Voltage gain (emitter follower output)	±AVE	R <sub>L</sub> = 600 Ω	4	04,05	+10		V/mV
(comment carefully			5,6		+8		
Voltage gain A <sub>V</sub> (collector)			4	06	+10		V/mV
7.0				07	+20		
			5,6	06	+5		
				07	+10		1
Response time, output saturated high	tHTHR	See figure 3, C <sub>L</sub> = 5 pF, 100 mV step,	9	01,03		60	ns
level to threshold level		5 mV overdrive		02		90	

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $\underline{1}/\underline{2}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Lir	mits	Unit
					Min	Max	
Response time, output saturated low level to threshold level	tLTHR	See figure 3, C <sub>L</sub> = 5 pF, 100 mV step, 5 mV overdrive	9	01,02, 03		60	ns
Strobe release time	tSTRL	See figure 4, $T_A = +25$ °C, $C_L = 5 \text{ pF}, V_{ID} = +10 \text{ mV}$	9	02,03		15	ns
Response time, low-to-high level	tRLHC	$V_{OD}$ (overdrive) = -5 V, $C_L = 50$ pF,	9,11	04,05		300	ns
collector output		V <sub>IN</sub> = 100 mV	10			640	
		V <sub>OD</sub> (overdrive) = -5 V, C <sub>L</sub> = 50 pF minimum,	9,11	06,07		125	
		V <sub>IN</sub> = 100 mV	10			160	
Response time, high-to-low level	tRHLC	$V_{OD}$ (overdrive) = +5 V, $C_L = 50 \text{ pF}$ ,	9,11	04,05		300	ns
collector output		V <sub>IN</sub> = 100 mV	10			500	
		$V_{OD}$ (overdrive) = +5 V, $C_L$ = 50 pF minimum, $V_{IN}$ = 100 mV	9,10,11	06,07		160	

- Unless otherwise specified, +V<sub>CC</sub> = +12 V dc and -V<sub>CC</sub> = -6 V. Unless otherwise specified, for device type 02, strobe on device not being tested is connected to ground; strobe on device being tested is left open. Unless otherwise specified, for device type 03, strobes are at a high level for all tests. For devices marked with the "Q" certification mark, the parameters listed herein may be guaranteed if not tested to the limits specified herein in accordance with the manufacturer's QM plan.
- $\underline{2}$ / For device types 04, 05, 06, and 07, unless otherwise specified, V<sub>IC</sub> = 0 V, ±V<sub>CC</sub> = ±15 V and −55°C ≤ T<sub>A</sub> ≤ +125°C. Limits apply to each half of device types 05, 06, and 07 except as noted for +I<sub>CC</sub> and -I<sub>CC</sub>.
- 3/ V<sub>IC</sub> is achieved by algebraically subtracting the common mode voltage from each V<sub>CC</sub> (power supplies) and algebraically adding it to V<sub>IN</sub>. V<sub>IC</sub> can be calculated by using the following formula:
  V<sub>IC</sub> = -[((+V<sub>CC</sub>) + (-V<sub>CC</sub>)) / 2] +V<sub>IN</sub>
- 4/ Subscript (R) indicates tests which are performed with input stage current raised by connecting BAL and BAL / STB terminals to +V<sub>CC</sub>.
- 5/ The output voltage follows the strobe voltage, staying one diode drop (0.7 V) below.

Device type		(	)1	
Case outlines	С	G	Н	2
Terminal number		Termina	al symbol	
1	NC	GND	GND	NC
2	GND	INPUT+	INPUT+	GND
3	INPUT+	INPUT-	INPUT-	NC
4	INPUT-	V <sub>CC</sub> -	NC	NC
5	NC	NC	V <sub>CC</sub> -	INPUT+
6	V <sub>CC</sub> -	NC	OUTPUT	NC
7	NC	OUTPUT	NC	INPUT-
8	NC	V <sub>CC+</sub>	V <sub>CC+</sub>	NC
9	OUTPUT		NC	NC
10	NC		NC	V <sub>CC</sub> -
11	V <sub>CC+</sub>			NC
12	NC			NC
13	NC			NC
14	NC			NC
15				NC
16				NC
17				OUTPUT
18				NC
19				NC
20				V <sub>CC+</sub>

NC = No connection

FIGURE 1. <u>Terminal connections</u>.

Device type		C	)2	
Case outlines	С	Н	I	2
Terminal number		Termina	l symbol	
1	NC	INPUT- 1	GND	NC
2	INPUT- 1	INPUT+ 1	STROBE 1	NC
3	INPUT+ 1	V <sub>CC</sub> -	INPUT – 1	INPUT- 1
4	V <sub>CC</sub> -	INPUT+ 2	INPUT+ 1	INPUT+ 1
5	INPUT+ 2	INPUT- 2	V <sub>CC</sub> -	NC
6	INPUT- 2	STROBE 2	INPUT+ 2	V <sub>CC</sub> -
7	NC	OUTPUT	INPUT- 2	NC
8	NC	V <sub>CC+</sub>	STROBE 2	INPUT+ 2
9	STROBE 2	GND	OUTPUT	INPUT- 2
10	OUTPUT	STROBE 1	V <sub>CC+</sub>	NC
11	V <sub>CC+</sub>			NC
12	GND			NC
13	STROBE 1			STROBE 2
14	NC			OUTPUT
15				NC
16				V <sub>CC+</sub>
17				NC
18				GND
19				STROBE 1
20				NC

NC = No connection

FIGURE 1. <u>Terminal connections</u> – Continued.

Device types	0	3		04	
Case outlines	А	G	С	G	H and Z
Terminal number			Terminal symbol		ı
1	NC	GND	NC	GND	GND
2	GND	INPUT+	GND	INPUT+	INPUT+ 1
3	INPUT+	INPUT-	INPUT+	INPUT-	INPUT- 1
4	INPUT-	V <sub>CC</sub> -	INPUT-	V <sub>CC</sub> -	NC
5	NC	STROBE 1	NC	BAL	V <sub>CC</sub> -
6	V <sub>CC</sub> -	STROBE 2	V <sub>CC</sub> -	BAL/STB	BAL
7	STROBE 1	OUTPUT	BAL	OUTPUT	BAL/STB
8	STROBE 2	V <sub>CC+</sub>	BAL/STB	V <sub>CC+</sub>	NC
9	OUTPUT		OUTPUT		OUTPUT
10	NC		NC		V <sub>CC+</sub>
11	V <sub>CC+</sub>		V <sub>CC+</sub>		
12	NC		NC		
13	NC		NC		
14	NC		NC		
15					
16					
17					
18					
19					
20					

NC = No connection BAL = Balance BAL / STB = Balance / Strobe

FIGURE 1. <u>Terminal connections</u> – Continued.

Device types	(	04	05
Case outlines	Р	2	E, F, and X
Terminal number		Terminal syn	nbol
1	GND	NC	V <sub>CC+</sub> A
2	INPUT+ 1	GND	GND A
3	INPUT- 1	NC	INPUT+ A
4	V <sub>CC</sub> -	NC	INPUT- A
5	BAL	INPUT+	V <sub>CC</sub> -
6	BAL/STB	NC	BAL B
7	OUTPUT	INPUT-	BAL/STB B
8	V <sub>CC+</sub>	NC	COLLECTOR OUTPUT B
9		NC	V <sub>CC+</sub> B
10		V <sub>CC</sub> -	GND B
11		NC	INPUT+ B
12		BAL	INPUT- B
13		NC	BAL A
14		NC	BAL/STB A
15		BAL/STB	COLLECTOR OUTPUT A
16		NC	NC
17		OUTPUT	
18		NC	
19		NC	
20		Vcc+	

NC = No connection BAL = Balance

BAL / STB = Balance / Strobe

FIGURE 1. <u>Terminal connections</u> – Continued.

Device types		06 and 07	
Case outlines	С	Н	I
Terminal number		Terminal symbol	
1	NC	OUTPUT 1	OUTPUT 1
2	NC	GND 1	GND 1
3	GND 1	INPUT+ 1	INPUT+ 1
4	INPUT+ 1	INPUT- 1	INPUT- 1
5	INPUT- 1	V <sub>CC</sub> -	V <sub>CC</sub> -
6	V <sub>CC</sub> -	OUTPUT 2	OUTPUT 2
7	OUTPUT 2	GND 2	GND 2
8	GND 2	INPUT+ 2	INPUT+ 2
9	INPUT+ 2	INPUT- 2	INPUT- 2
10	INPUT- 2	V <sub>CC+</sub>	V <sub>CC+</sub>
11	V <sub>CC+</sub>		
12	OUTPUT 1		
13	NC		
14	NC		

NC = No connection

FIGURE 1. <u>Terminal connections</u> – Continued.

# DEVICE TYPES 01 AND 02

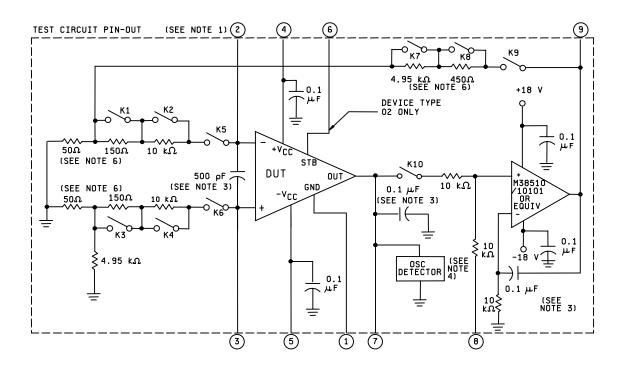


FIGURE 2. Test circuit for static and dynamic tests.

# DEVICE TYPE 03

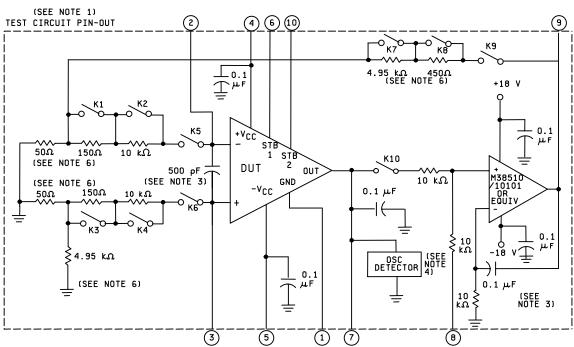


FIGURE 2. <u>Test circuit for static and dynamic tests</u> – continued.

### DEVICE TYPES 04 AND 05

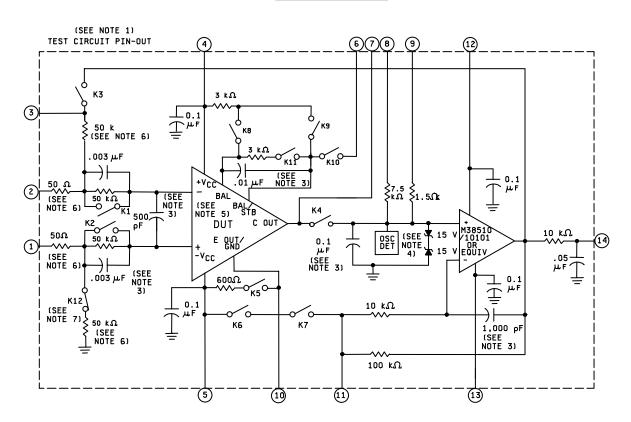


FIGURE 2. <u>Test circuit for static and dynamic tests</u> – continued.

# DEVICE TYPES 06 AND 07

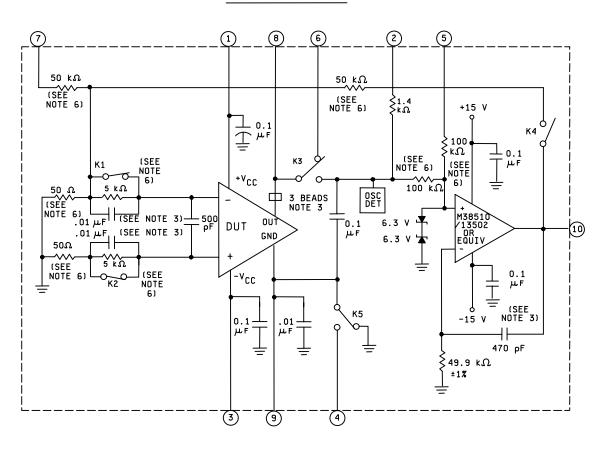
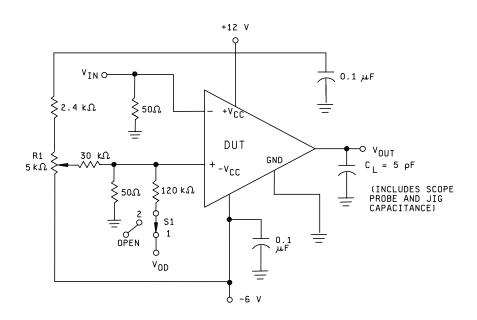


FIGURE 2. <u>Test circuit for static and dynamic tests</u> – continued.

- 1. Test circuit pin conditions and test temperatures shall be as specified in table III.
- 2. Precautions shall be taken to prevent damage to the device under test (DUT) during insertion into socket and change of relay switch positions (for example, disable voltage-current supplies, current limit  $\pm V_{CC}$ , etc.).
- 3. As required to prevent oscillations. Also, proper wiring procedures shall be followed to prevent oscillations. Loop response and settling time shall be consistent with test rate such that any value has settled to within 5 percent of its final value before value is measured. Suggested values shown may not ensure loop stability for all layouts. Actual compensation used shall be approved by the preparing activity prior to use.
- 4. Any oscillation greater than 300 mV(p-p) shall be cause for device failure.
- 5. For dual devices, both halves shall be tested. The output of the idle half shall be driven to the off state by using either a differential input voltage or a strobe input, or the idle half may be biased the same as the tested half if oscillations can be avoided.
- 6. These resistors are  $\pm 0.1$  percent tolerance matched to  $\pm 0.01$  percent. All other resistors are  $\pm 1$  percent tolerance and capacitors are 10 percent tolerance.
- 7. All relays are shown in the normal deenergized state.



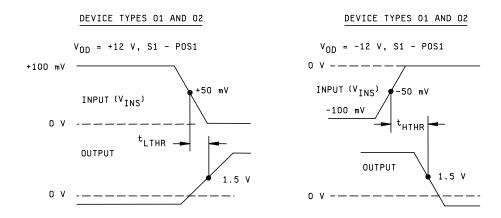
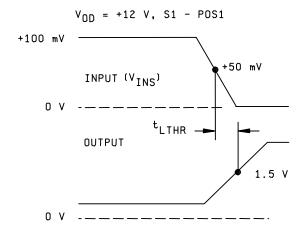
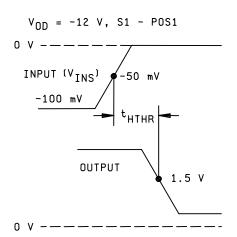


FIGURE 3. Response time test circuit and waveforms for device types 01, 02, and 03.

# DEVICE TYPE 03

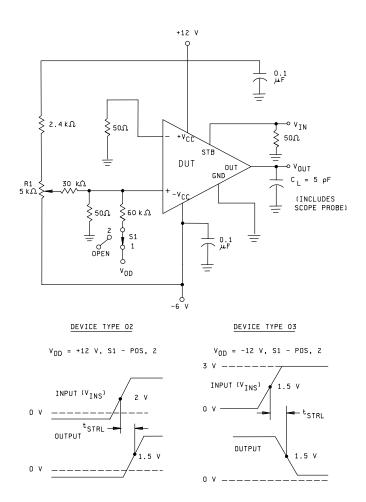


### DEVICE TYPE 03



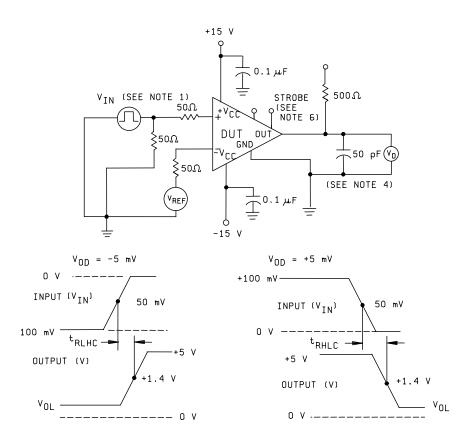
- 1.  $V_{IN} = 100$  ns pulse width, 100 kHz repetition rate,  $t_f$  and  $t_f \le 5$  ns (see waveforms).
- 2. Setup procedure: With S1 open and  $V_{IN} = 0$  adjust R1 for  $V_{OUT} = 1.5$  V. Apply  $V_{OD}$  (see note 5) and close S1, then apply  $V_{IN}$ . (R1 voltage divider may be replaced with a variable power supply.)
- 3. All resistor tolerances are  $\pm 1$  percent and all capacitor tolerances are  $\pm 10$  percent .
- 4. For device type 02, ground strobe on idle side. For device type 03, strobe is left open.
- 5. See waveforms for VOD values.
- 6. When  $V_{OD} = 12 \text{ V}$ , overdrive applied to device under test (DUT) = 5 mV.

FIGURE 3. Response time test circuit and waveforms for device types 01, 02, and 03 – continued.



- 1.  $V_{IN}$  = 100 ns pulse width, 100 kHz repetition rate,  $t_f$  and  $t_f \le 5$  ns (see waveforms).
- 2. Setup procedure: With S1 open and  $V_{IN} = 3 \text{ V}$  (device type 02), and  $V_{IN} = 0 \text{ V}$  (device type 03) adjust R1 for  $V_{OUT} = 1.5 \text{ V}$ . Apply  $V_{OD}$  (see note 5) and close S1, then apply  $V_{IN}$ . (R1 voltage divider may be replaced with a variable power supply.)
- 3. All resistor tolerances are  $\pm 1$  percent and all capacitor tolerance are  $\pm 10$  percent .
- 4. For device type 02, ground strobe on idle side. For device type 03, unused strobe is left open.
- 5. See waveform for V<sub>OD</sub> values.
- 6. When V<sub>OD</sub> = 12 V, overdrive applied to device under test (DUT) = 10 mV.

FIGURE 4. Strobe response time test circuit and waveforms for device types 02 and 03.



- 1.  $V_{IN}$  = 10  $\mu$ s pulse width at 50 kHz,  $t_{TLH}$  and  $t_{THL} \le$  10 ns, and  $Z_{O}$  = 50  $\Omega$ .
- 2. Setup procedure:
  - a. With  $V_{IN} = 0$  V, step  $V_{REF}$  from -3.0 mV to +3.0 mV in 0.1 mV steps for subgroup 7, -4.0 mV to +4.0 mV for subgroup 8, and stop when output switches from high to low.
  - b. Change V<sub>REF</sub> from the reference value obtained above by the required V<sub>OD</sub> (overdrive).
  - c. Apply V<sub>IN</sub> and measure response time.
- 3. All resistor tolerances are  $\pm 1$  percent and all capacitor tolerances are  $\pm 10$  percent.
- 4. CL includes scope, probe, and jig capacitance.
- 5.  $T_A = +25^{\circ}C$  for subgroup 7. For subgroup 8, the tests shall be performed twice, at  $T_A = +125^{\circ}C$  and  $T_A = -55^{\circ}C$ .
- 6. In an environment with excessive noise, a 0.01 μF capacitor may be placed between balance and balance/strobe pins.

FIGURE 5. Response time test circuit and waveforms for collector output for device types 04 and 05.

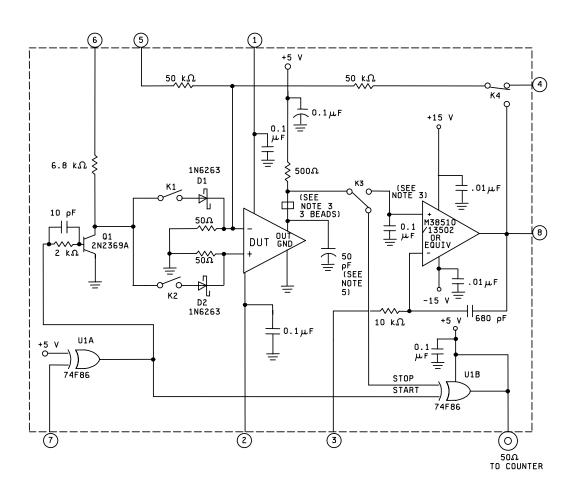


FIGURE 6. Response time test circuit for device types 06 and 07.

- 1. This circuit is designed especially to be used with a computer-controlled automatic tester, although it can also be implemented as a bench test setup. The test table for subgroups 9, 10, and 11 lists in detail the steps in a typical test sequence, which goes as follows:
  - a. Measure  $V_{IO}$ : Device under test (DUT) is in a conventional servo loop (K3 and K4 energized) with output served to TTL logic threshold. (1.4 V on adapter pin 3). Measure  $V_{IO}$  x 1000 adapter pin 8.
  - b. Null V<sub>IO</sub>: Release K3 and K4, apply voltage measured in step 1 to adapter pin 4. This is particularly easy to do on computer-controlled automatic test equipment.
  - c. Apply 5 mV overdrive (OD): The overdrive is developed at the inverting input of the device under test (DUT) via a 1000:1 divider from adapter pin 5.
  - d. Apply initial 100 mV: Close K1, apply 2 mA at adapter pin 6. Since Q1 is off, this current flows through Schottky diode D1 and the 50 Ω source resistor, giving 100 mV. If a current source is not available, 15 V at pin 6 will give about 2 mA current.
  - e. Measure t<sub>RLHC</sub>: Pull adapter pin 7 low. U1A output goes high, starting the timer via U1B and turning on Q1, which turns off D1. The 100 mV drive disappears abruptly, leaving just the 5 mV overdrive. After the response time, the device under test (DUT) output crosses TTL logic threshold and stops the timer via U1B. On a bench setup, the pulse at 1UB output can be measured with a scope.
  - f. Measure t<sub>RHLC</sub>: Reset pin 7, change pin 5 from –5 V to +5 V, open K1, close K2, pull pin 7 low, measure pulse width at U1B output.
- The following delay times are of possible concern in the LM119 (device types 06 and 07) response time test circuit:
  - a. U1A: This device merely inverts and squares up the start signal from the tester. Its gate delay does not affect the tests.
  - b. Q1: This is the major uncompensated delay, since the timer starts when Q1 base goes high, not when Q1 collector goes low. This delay is minimized by using a fast switching transistor with an R-C speedup network driving the base. Measured Q1 delays are well under 10 ns.
  - c. D1 and D2: These Schottky devices have negligible switching times ( < 1 ns).
  - d. U1B: The gate delays here are not important as long as the delays from the two inputs are well matched. (Matched delays merely offset the output pulse in time.) To minimize gate delay effects even further, we use one of the "fast" series 74F86 gates; with delays around 5 ns from each input, the mismatch should be no more than 1 or 2 ns.
  - e. Q2: This driver is required only if the time measurement systems has a 50  $\Omega$  input. Since it operates as an emitter follower rather than a saturating switch, there are no delays associated with it.
- 3. As required to prevent oscillations. Also, proper wiring procedures shall be followed to prevent oscillations. Loop response and settling time shall be consistent with test rate such that any value has settled to within 5 percent of its final value before value is measured. Suggested values shown may not ensure loop stability for all layouts. Actual compensation used shall be approved by preparing activity prior to use.
- 4. All resistor tolerances are ±1 percent and all capacitor tolerances are ±10 percent.
- 5. C<sub>L</sub> includes scope, probe, and jig capacitance.

TABLE II. Electrical test requirements.

MIL-PRF-38535 test requirements	Subgroups (se	e table III) <u>2</u> / <u>3</u> /
	Class S devices	Class B devices
Interim electrical parameters	1	1
Final electrical test parameters 1/	1,2,3,4	1,2,3,4
Group A test requirements	1,2,3,4,5,6, 7,8,9,10,11	1,2,3,4,5,6,7,8,9
Group B electrical test parameters when using the methods 5005 QCI option	1,2,3, and table IV delta limits	N/A
Group C electrical parameters	1,2,3, and table IV delta limits	1 and table IV delta limits
Group D end point electrical parameters	1,2,3	1

- 1/ PDA applies to subgroup 1.
- 2/ Subgroup 8 applies to device types 04 and 05 only.
- 3/ Subgroups 9, 10, and 11 apply to device types 06 and 07.

### 4. VERIFICATION.

- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as function as described herein.
- 4.2 <u>Screening</u>. Screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:
  - a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
  - b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
  - c. Additional screening for space level product shall be as specified in MIL-PRF-38535.

TABLE III. Group A inspection for device types 01 and 02. 1/

						ionoodoi i	2000	200	-  .ii				
Subgroup	Symbol	MIL-STD	Test				Adapter F	Adapter PIN numbers					Relay
		-883	no.										closed
		method		1	2	3	4	5	9	7	8	6	
-	VIO1	4001	1	GNĐ			+12.0 V	-6.0 V			-1.4 V		1,2,3,4,5,6,8,9,10
TA = +25°C	VIO2	n	2	n			n	п			"		2,4,5,6,8,9,10
	OII	и	3	я			и	и			77		1,3,5,6,8,9,10
	+IIB	n	4	n			n	п			"		1,2,3,5,6,7,9,10
(figure 2)	-IB	n	2	n			n	п			"		1,3,4,5,6,7,9,10
	CMR	4003	9	+5.0 V			+17.0 V	-2.0 V			-6.4 V		2,4,5,6,8,9,10
	CMR	4003	7	-5.0 V			47.0 V	-12.0 V			+3.6 V		2,4,5,6,8,9,10
	+ICC	3008	8	GNĐ		/2	+12.0 V	-6.0 V					1,2,5
	-lcc	3008	6	n		n	п	и					1,2,5
	NOL	3007	10	n		n	и	и					1,2,5
	IOL	3009	11	n		n	п	и					1,2,5
	VOH1	3008	12	n	2/		п	и		-5 mA			3,4,6
	VOH2	3006	13	n	и		и	и					3,4,6
	VO(STB) <u>3</u> ∕	3007	14	я	и		и	и	300 mV				3,4,6
	lO(SТВ) <u>3</u> /	3009	15	я	11		и	11	100 mV				3,4,6
2	VIO1	4001	16	я			и	и			-1.0 V		1,2,3,4,5,6,8,9,10
TA = +125°C	VIO2	4001	17	z			z	z			-1.0 V		2,4,5,6,8,9,10
	∆VIO/∆T 4/		18	Calculation	ΓΔ / OΙVΔ∷r	r = [VIO (test	Calculation: $\Delta V_{IO}$ / $\Delta T$ = [VIO (test 16) – VIO (test 1)] x 10 $^3$ / 100°C	st 1)] x 10 <sup>3</sup> ,	′ 100°C				
	Ol	4001	19	GND			+12.0 V	-6.0 V			-1.0 V		1,3,5,6,8,9,10
(figure 2)	AIO/AT 4/		20	Calculation	n: Aljo/AT	= [IIO (test 1	Calculation: $\Delta IIO / \Delta T = [IIO (test 19) - IIO (test 3)] \times 10^3 / 100^{\circ}C$	3)] × 10 <sup>3</sup> / 10	20°C				

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and 02- continued. 1/

Subgroup	Symbol	MIL-STD	Test		Pin measured		Equation			ا ا	Limits		
		-883	0				•	De	Device type 01	Σ		Device type 02	02
		method		o N	Value	Unit		Min	Max	Unit	Min	Max	Unit
-	VIO1	4001	1	6	E1	>	VIO = 10E1	-2	+2	Λm	-3.5	+3.5	Λm
TA = +25°C	VIO2	79	2	н	E2	и	VIO = 10E2	-2	+2	νm	-3.5	+3.5	mV
	Oll	33	ဧ	ä	E3	ä	I <sub>1</sub> O = E <sub>1</sub> – E <sub>3</sub>	-3	£+	нΑ	-10	+10	μA
	+IIB	79	4	н	E4	и	+IIB = E1 – 10E4	-0.1	+20	μА	-0.1	+75	μA
(figure 2)	all-	***	2	и	E5	и	-IIB = 10E5 – E1		+20	нΑ	-0.1	+75	μА
	CMR	4003	9	6	E6	я	CMR = $20 \log [10^3 / (E_6 - E_7)]$	08+		Яþ	+80		dB
	CMR	4003	2	6	E7	и							
	JJ +	3005	8	4	+ICC	mA		40.5	0.6+	Αm	+0.5	+13.5	mA
	22 -	3002	6	5	-ICC	mA		-7.0	9.0-	МA	-6.2	-0.5	mA
	NOL	3007	10	7	VOL	^		-1.0		^	-1.0		۸
	ПОІ	3009	11	n	IOL	mA		+2.0		МA	+0.5		mA
	VOH1	3006	12	и	VОН1	^		+2.5	+5.0	^	+2.5	+5.0	۸
	VOH2	3006	13	и	VOH2	^		+2.5	+5.0	^	+2.5	+5.0	۸
	VO(STB) <u>3</u> ∕	3007	14	и	VO(STB)	^					-1.0		۸
	lO(STB) <u>3</u> /	3009	15	6	lO(STB)	mA					-2.5	-0.1	mA
2	VIO1	4001	16	6	E8	^	VIO = 10E8	-3	+3	νm	-4.5	+4.5	mV
TA = +125°C	VIO2	4001	17	6	E9	>	VIO = 10E9	-3	+3	۸m	-4.5	+4.5	mV
	∆VIO/∆T 4/		18					-10	+10	о,//\π	-10	+10	μV/°C
	Oll	4001	19	6	E10	>	I <sub>1</sub> O = E <sub>8</sub> – E <sub>10</sub>	-3	£ +	нΑ	-10	+10	μA
(figure 2)	∆IO/∆T 4/		20					-25	+25	nA/°C	-25	+25	nA/°C

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and  $02 - \omega$ ntinued. 1/

MIL-STD	D Test				Adapter	Adapter PIN numbers	vo.				Relay
-883 u	no.										closed
method		_	2	8	4	2	9	7	80	6	
4001 2	21	GND			+12.0 V	Λ 0.9-			-1.0 V		1,2,3,5,6,7,9,10
22	01	GND			+12.0 V	-6.0 V			-1.0 V		1,3,4,5,6,7,9,10
4003 23		+5.0 V			+17.0 V	-2.0 V			-6.0 V		2,4,5,6,8,9,10
4003 24	ı	-5.0 V			47.0 V	-12.0 V			+4.0 V		2,4,5,6,8,9,10
3005 25		GND		2/	+12.0 V	-6.0 V					1,2,5
3005 26		"		u	39	n					1,2,5
3007 27		и		и	79	n					1,2,5
3009 28		ä		и	29	n					1,2,5
3006 29		"	2/		29	n		-5 mA			3,4,6
3006		n	"		79	n					3,4,6
3007 31		и	,,		77	и	300 mV				3,4,6
3009 32		ži.	n		79	и	100 mV				3,4,6
33		ži.			79	и			-1.8 V		1,2,3,4,5,6,8,9,10
34		ži.			79	и			-1.8 V		2,4,5,6,8,9,10
35		Calculation	n: AVIO/AT	= [VIO (tes	Calculation: $\Delta V_{IO}$ / $\Delta T = [V_{IO}$ (test 33) – $V_{IO}$ (test 1)] x 10 $^3$ / $80^{\circ}$ C	est 1)] x 10 <sup>3</sup>	7°08 /				
36		GND			+12.0 V	-6.0 V			-1.8 V		1,3,5,6,8,9,10
37		Calculation	n: AljO / AT	= [IlO (test ;	Calculation: $\Delta I_{O} / \Delta T = [I_{O} \text{ (test 36)} - I_{O} \text{ (test 3)}] \times 10^{3} / 80^{\circ}C$	:3)]×10 <sup>3</sup> /8	30°C				

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and  $02 - \infty$ ntinued. 1/

		0.5	Unit	Αμ	Рη	æ		mA	mA	>	mA	>	>	>	mA	/m	/m	ην/°C	Рή	nA/°C
		Device type 02	Max	+75	+75			+13.5	-0.5			+5.0	+5.0		-0.1	+4.5	+4.5	+10	+20	+75
	Limits		Min	-0.1	-0.1	+80		+0.5	-6.2	-1.0	+0.12	+2.5	+2.5	-1.0	-2.5	-4.5	-4.5	-10	-20	-75
	ā	1	Unit	Рη	Рη	dВ		mA	mA	>	mA	>	^			/m	/m	μV/°C	Рη	nA/°C
		Device type 01	Мах	+20	+20			+9.0	-0.5			+5.0	+5.0			+3	+3	+10	<b>Z</b> +	+75
		De	Min	-0.1	-0.1	+80		+0.5	-7.0	-1.0	+0.5	+2.5	+2.5			-3	-3	-10	<i>L</i> -	-75
	Equation			+IIB = E8 – 10E11	-IIB = 10E12 – E8	CMR = 20 $\log [10^3 / (E_{13} - E_{14})]$										VIO = 10E15	VIO = 10E16		IIO = E15 – E17	
			Unit	>	79	11	77	mA	mA	>	mA	>	^	>	mA	>	>		>	
	Pin measured		Value	E11	E12	E13	E14	+ICC	-lcc	VOL	IOL	VOH1	УОН2	VO(STB)	lO(STB)	E15	E16		E17	
	₫.		O	6	"	"	"	4	5	7	"	"	"	"	9	6	6		6	
•	Test	no.		21	22	23	24	25	26	27	28	59	30	31	32	33	34	35	36	37
	MIL-STD	-883	method	4001	4001	4003	4003	3005	3005	3007	3009	3006	3006	3007	3009	4001	79	"	"	39
	Symbol			HIB	8I <sub>I</sub> -	CMR	CMR	DOI+	22 -	ТОЛ	TOI	VOH1	МОН2	VO(STB) <u>3</u> ∕	\£ (8T8)Ol	VIO1	VIO2	\ <u>4</u> \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	Oli	∆lo/∆T 4/
•	Subgroup			2	TA = +125°C			(figure 2)								3	TA = -55°C			(figure 2)

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and 02 – continued.  $\overline{1}/$ 

	Relay	closed		1,2,3,5,6,7,9,10	1,3,4,6,7,9,10	2,4,5,6,8,9,10	2,4,5,6,8,9,10	1,2,5	1,2,5	1,2,5	1,2,5	3,4,6	3,4,6	3,4,6	3,4,6	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10
=			6																
			8	-1.8 V	-1.8 V	√8.9-	+3.2 V									-1.9 V	V 6.0-	-1.5 V	-0.5 V
-ì			7									-5 mA							
T T	6		6											300 mV	100 mV				
מומים ו	Adapter PIN numbers		5	-6.0 V	-6.0 V	-2.0 V	-12.0 V	-6.0 V	"	и	и	n	и	и	"	и	и	и	я
odkioo kko	Adapter		4	+12.0 V	+12.0 V	+17.0 V	47.0 V	+12.0 V	n	n	n	,,	n	и	"	n	и	"	55
			3					2/	и	n	n								
			2									2/	и	и	"				
			1	GND	GND	+5.0 V	-5.0 V	GND	и	"	"	n	"	я	n	"	и	"	u
•	Test	no.		38	39	40	41	42	43	44	45	46	47	48	49	20	51	52	53
	MIL-STD	-883	method	4001	4001	4003	4003	3005	3005	3007	3009	3006	3006	3007	3009	4004	"	"	3
	Symbol			+IB	-lıB	CMR	CMR	+ICC	-lcc	NOL	IOL	УОН1	VOH2	VO(STB) <u>3</u> ∕	Ю(ЅТВ) <u>3</u> /	AV+	AV-	AV+	AV-
	Subgroup			ε	TA = -55°C			(figure 2)								4	TA = +25°C (see figure 2)	5	TA = +125°C (see figure 2)

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and 02- continued. 1/

	9 02	Unit	μА	μА	дB		mA	mA	^	mA	^	^	>	mA	///	3	n	3
	Device type 02	Max	+150	+150			+13.5	-0.5			+5.0	+5.0		-0.1				
Limits		Min	-0.1	-0.1	+80		+0.5	-6.2	-1.0	+0.25	+2.5	+2.5	-1.0	-2.5	+750	+750	+500	+500
<u>'</u>	_	Unit	μА	μА	dB		mA	mA	^	mA	^	^			///	*	"	¥
	Device type 01	Max	+45	+45			+9.0	-0.5			+5.0	+5.0						
	De	Min	-0.1	-0.1	+80		+0.5	-7.0	-1.0	+1.0	+2.5	+2.5			+1,250	+1,250	+1,000	+1,000
Equation			+IIB = E15 - 10E18	-IIB = 10E19 – E15	CMR = $20 \log [10^3 / (E_{20} - E_{21})]$										$AV+ = 50 / (E_1 - E_{22})$	Αν-= 50 / (E1 – E23)	AV + = 50 / (E8 - E24)	AV-=50 / (E8 – E25)
		Unit	۸	и	и	"	mA	mA	۸	mA	۸	۸	٧	mA	۸	3	и	n
Pin measured		Value	E18	E19	E20	E21	+ICC	-lcc	VOL	lOL	VOH1	VОН2	VO(STB)	lO(STB)	E22	E23	E24	E25
ia.		No.	6	и	я	ä	4	5	7	я	и	я	я	9	6	o	6	o
Test	no.		38	39	40	41	42	43	44	45	46	47	48	49	20	51	52	53
MIL-STD	-883	method	4001	4001	4003	4003	3005	3005	3007	3009	3006	3006	3007	3009	4004	ä	я	3
Symbol			+IIB	-IB	CMR	CMR	+ICC	-lcc	NOL	IOL	VOH1	VOH2	VO(STB) <u>3</u> /	IO(STB) <u>3</u> /	AV+	AV-	AV+	AV-
Subgroup			3	TA = -55°C			(figure 2)								4	TA = +25°C (figure 2)	2	TA = +125°C (figure 2)

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and  $02 - \cot inued$ . 1/

Subgroup	Symbol	MIL-STD	Test	:			Adapter	Adapter PIN numbers		1			Relay
		-883	90.										pesolo
		method		-	2	ဇ	4	2	9	7	80	6	
9	AV+	4004	54	GND			+12.0 V	-6.0 V			-2.3 V		1,2,3,4,5,6,8,9,10
TA = -55°C (figure 2)	AV-	3	55	GND			+12.0 V	-6.0 V			-1.3 V		1,2,3,4,5,6,8,9,10
7	tLTHR		56	These tests	shall be pe	rformed usir	These tests shall be performed using test conditions and procedures listed on figure 3.	ons and proc	sedures list	ed on figu	re 3.		
TA = +25°C	tHTHR		57										
	tSTRL 3/		28	These tests	shall be pe	rformed usi	These tests shall be performed using test conditions and procedures listed on figure 4.	ons and proc	sedures list	ed on figu	re 4.		

See footnotes at end of device types 01 and 02.

TABLE III. Group A inspection for device types 01 and  $02 - \cot inued$ . 1/

	e 02	Unit	///	з	su	su	su
	Device type 02	Мах			09	06	15
Limits		Min	+500	+500			
ij	1	Unit	\/\	я	su	ns	
	Device type 01	Мах			09	09	
	e D	Min	+1,000	+1,000			
Equation			AV + = 50 / (E15 - E26)	AV-=50 / (E15 – E27)			
		Unit	^	¥			
Pin measured		Value	E26	E27			
д		ON	6	3			
Test	no.		54	55	99	22	58
MIL-STD	-883	method	4004	y	n	"	"
Symbol			+/\A	-/\A	t <sub>L</sub> THR	tHTHR	tstrl 3/
Subgroup			9	TA = -55°C (figure 2)	2	TA = +25°C	

1/2. For devices marked with the "Q" certification mark, the parameters listed herein may be guaranteed if not tested to the limits specified herein in accordance with the manufacturer's QM plan.

2/ For device type 01, use -5 mV; for device type 02, use -10 mV.

3/ Device type 02 only.

4/ Test numbers 18, 20, 35, and 37, which require read and record measurements plus a calculation, may be omitted except when subgroups 2 and 3 are being performed for group A sampling inspections and group C end points.

Δ Represents delta.

TABLE III. Group A inspection for device type 03.1

diographic	S Code	OTO IIM	T.00					and Mo sotock	or other				
dnoibano	Ogilloo	ואווריטוע	100					idapter r III	s included in				
		-883	no.										
		method		-	2	ဇ	4	2	9	7	80	6	10
1	VIO1	4001	1	GND			+12.0 V	-6.0 V			-1.5 V		
TA = +25°C	VIO2	3	2	3			3	3			3		
	OII	n	3	3			n .	п			"		
	HIB	"	4	3			3	79			"		
(figure 4)	-IB	"	5	n			n	п			"		
	CMRR	4003	9	+5.0 V			+17.0 V	-2.0 V			-6.5 V		
	CMRR	4003	7	-5.0 V			+7.0 V	-12.0 V			+3.5 V		
	+ICC	3008	8	GND		-5 mV	+12.0 V	-6.0 V					
	-ICC	3002	9	и		п	и	и					
	NOL	3007	10	n		n	n	п		+100 mA			
	МОМ	3006	11	и	-5 mV		и	и		-0.4 mA			
	ICEX		12	з	-5 mV		z	z		+24 V			
	VO(STL)1		13	з		-5 mV	z	z	+0.9 V				
	VO(STL)2		14	и		и	и	и					+0.9 V
	VO(STH)1		15	и		и	и	и	+2.5 V	+16 mA			
	VO(STH)2		16	з		z	я	и		+16 mA			+2.5 V
	ISTB1		17	з		z	я	и	+0.4 V				
	ISTB2		18	и		и	и	и					+0.4 V
2	VIO1	4001	19	и			и	и			-1.5 V		
TA = +125°C	VIO2	ä	20	z			я	z			-1.5 V		
	∆VIO/∆T <u>2</u> /	**	21	Calculation	n: AVIO/A	= [VIO (test	Calculation: $\Delta V_{IO}$ / $\Delta T$ = [VIO (test 19) – VIO (test 1)] x 10 $^3$ / 100°C	st 1)] x 10 <sup>3</sup>	/ 100°C				
	Oll	4001	22	GND			+12.0 V	-6.0 V			-1.5 V		
(figure 4)	∆IO/∆T <u>2</u> /	3	23	Calculation	n: Aljo/AT	= [I <sub>I</sub> O (test 2	Calculation: $\Delta I_{O} / \Delta T = [I_{O} \text{ (test 22)} - I_{O} \text{ (test 3)]} \times 10^{3} / 100^{\circ}C$	3)] × 10 <sup>3</sup> / 10	2,00°C				

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

Subdroup	lodmyS	CTS- IIM	Tool	Relave		Din measured		Tailation		i	
5	5		5	2600							
		-883	no.	energized							
		method			No.	Value	Unit		Min	Мах	Unit
1	VIO1	4001	1	1,2,3,4,5,6,8,9,10	6	E1	^	VIO = 10E1	-2.0	+2.0	mV
TA = +25°C	VIO2	я	2	2,4,5,6,8,9,10	ä	E2	"	VIO = 10E2	-2.0	+2.0	mV
	Oll	"	3	1,3,5,6,8,9,10	n	E3	"	I <sub>1</sub> O = E <sub>1</sub> – E <sub>3</sub>	-3.0	+3.0	μА
	#IB	n	4	1,2,3,5,6,7,9,10	n	E4	"	+IIB = E1 – 10E4	-0.1	+20	μА
(figure 4)	-IIB	n	2	1,3,4,5,6,7,9,10	и	E5	и	-IIB = 10E5 – E1	-0.1	+20	μА
	CMRR	4003	9	2,4,5,6,8,9,10	n	E6	**	CMR = $20 \log [10^3 / (E_6 - E_7)]$	08+		dB
	CMRR	4003	7	2,4,5,6,8,9,10	и	E7	и				
	+ICC	3005	8	1,2,5	4	+ICC	mA		+0.5	+10	mA
	-loc	3005	6	1,2,5	2	-lcc	mA		-3.6	-0.5	mA
	NOL	3007	10	1,2,5	7	VOL	^			+1.5	۸
	МОЛ	3006	7	3,4,6	z	МОИ	>		+2.5	+5.5	^
	ICEX		12	3,4,6	z	ICEX	μА		01	+	μА
	VO(STL)1		13	1,2,5	ä	VO(STL)1	^		+2.5	+5.5	۸
	VO(STL)2		14	1,2,5	з	VO(STL)2	**		+2.5	+5.5	z
	VO(STH)1		15	1,2,5	ä	VO(STH)1	39			+0.4	×
	VO(STH)2		16	1,2,5	ä	VO(STH)2	39			+0.4	×
	ISTB1		17	1,2,5	9	ISTB1	шА		-3.3	-0.1	mA
	ISTB2		18	1,2,5	10	ISTB2	mA		-3.3	-0.1	mA
2	V <sub>IO</sub> 1	4001	19	1,2,3,4,5,6,8,9,10	6	E8	>	VIO = 10E8	-3.0	+3.0	mV
TA = +125°C	V <sub>I</sub> O2	3	20	2,4,5,6,8,9,10	6	E9	>	VIO = 10E9	-3.0	+3.0	mV
	∆VIO/∆T <u>2</u> /	3	21						-10	+10	μV/°C
	Ol	3	22	1,3,5,6,8,9,10	6	E10	>	I <sub>1</sub> O = E <sub>8</sub> – E <sub>10</sub>	-3.0	+3.0	μА
(figure 4)	AIO/AT 2/	з	23						-25	+25	nA/°C

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

Subgroup	Symbol	MIL-STD	Test				1	Adapter PIN numbers	numbers				
		-883	no.										
		method		1	2	3	4	5	6	7	8	6	10
1	#IB	4001	24	GND			+12.0 V	-6.0 V			-1.5 V		
TA = +25°C	-IB	"	25	GNĐ			+12.0 V	-6.0 V			-1.5 V		
	CMRR	4003	56	7 0.2+			+17.0 V	-2.0 V			-6.5 V		
	CMRR	4003	27	-5.0 V			V 0.7+	-12.0 V			+3.5 V		
(figure 4)	20I+	3005	28	GNĐ		/m 2-	+12.0 V	-6.0 V					
	-Icc	3005	29	n		n	n	"					
	NOL	3007	30	n		n	n	и		+16 mA			
	МОИ	3006	31	я	-5 mV		и	и		-0.4 mA			
	ICEX		32	n	-5 mV		n	и		+24 V			
	VO(STL)1		33	я		-5 mV	и	и	+0.9 V				
	VO(STL)2		34	я		и	и	и					+0.9 V
	VO(STH)1		35	n		n	n	и	+2.5 V	+16 mA			
	VO(STH)2		36	я		и	и	и		+16 mA			+2.5 V
2	ISTB1		37	я		и	и	и	+0.4 V				
TA = +125°C (figure 2)	ISTB2		38	z		z	и	ŭ					+0.4 V

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 – continued. 1/

Subgroup	Symbol	MIL-STD	Test	Relays		Pin measured		Equation		Limits	
		-883	no.	energized							
		method			No.	Value	Unit		Min	Мах	Unit
2	#IIB	4001	24	1,2,3,5,6,7,9,10	6	E11	^	+IIB = E8 – 10E11		+20	μА
TA = +125°C	-IIB	я	25	1,3,4,5,6,7,9,10	и	E12	**	-IIB = 10E12 - E8		+20	μА
	CMRR	4003	26	2,4,5,6,8,9,10	n	E13	"	CMR = $20 \log [10^3 / (E_{13} - E_{14})]$	08+		дB
	CMRR	4003	27	2,4,5,6,8,9,10	n	E14	"				
(figure 4)	+ICC	3005	28	1,2,5	4	+ICC	mA		+0.5	+10	mA
	-Icc	3005	29	1,2,5	5	-ICC	mA		-3.6	-0.5	mA
	VOL	3007	30	1,2,5	7	VOL	^			+0.4	>
	МОН	3006	31	3,4,6	и	МОН	^		+2.5	+5.5	>
	ICEX		32	3,4,6	и	ICEX	μА		-0.5	+100	μА
	VO(STL)1		33	1,2,5	n	VO(STL)1	^		+2.5	+5.5	^
	VO(STL)2		34	1,2,5	n	VO(STL)2	n		+2.5	+5.5	и
	VO(STH)1		35	1,2,5	и	VO(STH)1	ш			+0.4	и
	VO(STH)2		36	1,2,5	3	VO(STH)2	77			+0.4	z
2	ISTB1		37	1,2,5	9	ISTB1	mA		-3.3	-0.1	mA
TA = +125°C (figure 2)	ISTB2		38	1,2,5	10	ISTB2	мА		-3.3	-0.1	mA

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

		10																+0.9 V		+2.5 V		+0.4 V
		6																				
		8																				
		7												+50 mA	-0.4 mA	+24 V			+16 mA	+16 mA		
numbers		9			7°08 /		0°C										+0.9 V		+2.5 V		40.4 V	
Adapter PIN numbers		5	-6.0 V	-6.0 V	st 1)] x 10 <sup>3</sup> ,	-6.0 V	3)] x 10 <sup>3</sup> / 80	-6.0 V	-6.0 V	-2.0 V	-12.0 V	-6.0 V	u	и	п	и	и	и	и	и	и	3
		4	+12.0 V	+12.0 V	Calculation: $\Delta V_{IO}$ / $\Delta T = [V_{IO}$ (test 39) – $V_{IO}$ (test 1)] x 10 $^3$ / 80°C	+12.0 V	Calculation: $\Delta I_{IO}$ / $\Delta T = [I_{IO}$ (test 42) – $I_{IO}$ (test 3)] x 10 $^3$ / $80^{\circ} C$	+12.0 V	+12.0 V	+17.0 V	+7.0 V	+12.0 V	и	и	"	и	u	и	и	и	и	3
		3			「=[VIO (test		= [IIO (test 4					-5 mV	n	n			-5 mV	и	и	и	n	3
		2			n: ΔVIO/Δ		n: Aljo/AT								-5 mV	-5 mV						
		1	GND	GND	Calculation	GND	Calculation	GND	GNĐ	∧ 0.2+	-5.0 V	GNĐ	ä	n	n	n	n	и	и	и	n	3
Test	no.		39	40	41	42	43	44	45	46	47	48	49	50	51	52	53	54	55	56	57	58
MIL-STD	-883	method	4001	n	n	n	n	n	"	4003	4003	3005	3005	3007	3006							
Symbol			V <sub>IO</sub> 1	VIO2	∆VIO/∆T <u>2</u> /	Oll	∆IO/∆T <u>2</u> /	+IIB	-IB	CMRR	CMRR	+ICC	-lcc	NOL	МОН	ICEX	VO(STL)1	VO(STL)2	VO(STH)1	VO(STH)2	ISTB1	ISTB2
Subgroup			8	TA = -55°C	(figure 2)																	

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

		Unit	mV	mV	μV/°C	μA	nA/°C	μА	μА	дB		mA	mA	>	>	μА	^	и	и	и	mA	mA
Limits		Мах	+3	+3	+10	<b>L</b> +7	+75	+45	+45			+10	-0.5	+1.0	+5.5	+100	+5.5	+5.5	+0.4	+0.4	-0.1	-0.1
		Min	-3	-3	-10	2-	-75			+80		+0.5	-3.6		+2.5	-0.5	+2.5	+2.5			-3.3	-3.3
Equation			VIO = 10E15	VIO = 10E16		IIO = E15 - E17		+IIB = E15 – 10E18	-IIB = 10E19 - E15	CMRR = $20 \log [10^3 / (E_{20} - E_{21})]$												
		Unit	^	۸		۸		٧	и	и	и	mA	mA	^	^	μА	۸	и	и	и	mA	mA
Pin measured		Value	E15	E16		E17		E18	E19	E20	E21	+ICC	-lcc	VOL	МОН	ICEX	VO(STL)1	VO(STL)2	VO(STH)1	VO(STH)2	ISTB1	ISTB2
		No.	6	6		6		6	я	и	n	4	5	7	n	n	и	и	и	и	9	10
Relays	energized		1,2,3,4,5,6,8,9,10	2,4,5,6,8,9,10		1,3,5,6,8,9,10		1,2,3,5,6,7,9,10	1,3,4,5,6,7,9,10	2,4,5,6,8,9,10	2,4,5,6,8,9,10	1,2,5	1,2,5	1,2,5	3,4,6	3,4,6	1,2,5	1,2,5	1,2,5	1,2,5	1,2,5	1,2,5
Test	ю.		39	40	41	42	43	44	45	46	47	48	49	50	51	52	53	54	55	99	22	58
MIL-STD	-883	method	4001	n	n	"	n	n	n	4003	4003	3005	3005	3007	3006							
Symbol			VIO1	VIO2	ΔV <sub>I</sub> Ο/ΔT <u>2</u> /	Oll	∆IO/∆T <u>2</u> /	8II+	-lIB	CMRR	CMRR	+ICC	-lcc	VOL	МОН	ICEX	VO(STL)1	VO(STL)2	VO(STH)1	VO(STH)2	ISTB1	lSTB2
Subgroup			8	TA = -55°C	(figure 2)																	

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

Subgroup	Symbol	MIL-STD	Test				4	Adapter PIN numbers	numbers				
		-883	ю.										
		method		-	2	ъ	4	2	9	7	8	0	10
4	AV+	4004	59	GND			+12.0 V	-6.0 V			-4.5 V		
TA = +25°C (figure 2)	-^Y	4004	09	n			з	y			√ 5.0-		
5	AV+	4004	61	*			:	3			-4.5 V		
TA = +125°C (figure 2)	-∧∀	4004	62	n			з	y			√ 5.0-		
9	+/\A	4004	63	"			n	"			-4.5 ∨		
TA = -55°C (figure 2)	-∧∀	4004	64	"			я	y			-0.5 V		
7	tLTHR		99	These tests	s shall be per	rformed usin	These tests shall be performed using test conditions and procedures listed on figure 3.	ons and proce	edures listed	on figure 3	mi.		
TA = +25°C	tHTHR		99										
	tSTRL1		29	These tests	s shall be per	rformed usin	These tests shall be performed using test conditions and procedures listed on figure 4.	ons and proce	edures listed	on figure 4	ï		
	tSTRL2		89										

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type 03 - continued. 1/

			Unit	///	z	и	æ	я	æ	ns	ä	ä	ä
	Limits		Мах							09	09	15	15
			Min	08+	+30	+10	+10	05+	09+				
	Equation			AV+ = 300 / (E1 – E22)	ΑV-=100 / (E23 – E1)	AV+ = 300 / (E8 - E24)	ΑV-= 100 / (E25 – E8)	AV + = 300 / (E15 - E26)	AV- = 100 / (E27 – E15)				
ol device typ	J		Unit	۸	n	n	"	n	n				
IIISPACKIOII	Pin measured		Value	E22	E23	E24	E25	E26	E27				
III. Gloup A	F		No.	6	и	и	n	п	n				
I ABLE	Relays	energized		1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10	1,2,3,4,5,6,8,9,10				
	Test	no.		59	09	61	62	63	64	92	99	67	89
	MIL-STD	-883	method	4004	я	n	з	3	3				
	Symbol			AV+	AV-	AV+	AV-	AV+	AV-	tLTHR	tHTHR	tSTRL1	tSTRL2
	Subgroup			4	TA = +25°C (figure 2)	5	TA = +125°C (figure 2)	9	TA = -55°C (figure 2)	2	TA = +25°C		

1/ For devices marked with the "Q" certification mark, the parameters listed herein may be guaranteed if not tested to the limits specified herein in accordance with the manufacturer's QM plan.

2/ Test numbers 21, 23, 41, and 43, which require read and record measurements plus a calculation, may be omitted except when subgroups 2 and 3 are being performed for group A sampling inspections and group C end points.

# △ Represents delta.

TABLE III. Group A inspection for device types 04 and 05 .  $1\!\!\!/$ 

		12	+20.0 V	з	з	з	3	3	3	3	3	3	3	з	3	з	з	з	3		+20.0 V	+20.0 V
		11	GND	+14.5 V	-13.0 V	GND	GND	+14.5 V	-13.0 V	GND	+14.5 V	-13.0 V	GND	GND	+14.5 V	-13.0 V	GND	+14.5 V	-13.0 V		GND	GND
		10																				
		9																				
		8	+15.0 V	+29.5 V	+2.0 V	+2.5 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	"	19
numbers		7																				
Adapter PIN numbers		9					+15.0 V	+29.5 V	+2.0 V				+15.0 V							-3 mA		
		5	-15.0 V	-0.5 V	-28.0 V	-2.5 V	-15.0 V	-0.5 V	-28.0 V	-15.0 V	-0.5 V	-28.0 V	-15.0 V	-15.0 V	-0.5 V	-28.0 V	-15.0 V	-0.5 V	-28.0 V	-15.0 V	3	ä
		4	+15.0 V	+29.5 V	+2.0 V	+2.5 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V	+15.0 V	3	и
		3																				
		2	GNĐ	"	"	"	3	3	3	3	3	3	"	"	3	"	"	"	3	+15.0 V	GNĐ	GND
		1	GND	3	3	3	3	3	3	3	3	3	я	3	3	3	3	3	3	3	3	ä
Test	no.		1	2	ε	4	5	9	2	8	6	10	11	12	13	14	15	16	17	18	19	20
MIL-STD	-883	method	4001	n	n	n	я	я	я	я	я	я	n	9	3	3	3	3	3	3	3	я
Symbol			ΟlΛ				VIO(R)			ol			lo(R)	HIB			8II-			VO(STB)	VIO(ADJ)+	VIO(ADJ)-
Subgroup			٢	TA = +25°C	(figure 2)																	

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 – continued. 1/

Subgroup	Symbol	MIL-STD	Test	Adapter pin	er pin	Relays	_	Pin measured	מ	Equation		Limits	
		-883	no.	numbers	oers	energized							
		method		13	14		No.	Value	Unit		Min	Мах	Unit
٢	ΟlΛ	4001	1	-20.0 V		1,2,3,4,5	14	E1	^	VIO = E1	-3	+3	mV
TA = +25°C		99	2	n		1,2,3,4,5	"	E2	n	VIO = E2	3	,,	и
(figure 2)		39	3	n		1,2,3,4,5	"	E3	n	VIO = E3	3	,,	и
		19	4	n		1,2,3,4,5	"	E4	n	VIO = E4	3	,,	и
	VIO(R)	9	2	3		1,2,3,4,5,8,9,10	n	E5	"	VIO(R) = E5	3	,,	и
		99	9	n		1,2,3,4,5,8,9,10	"	E6	n	VIO(R) = E6	3	,,	и
		19	7	n		1,2,3,4,5,8,9,10	"	E7	n	VIO(R) = E7	3	,,	и
	OII	3	8	я		3,4,5	"	E8	и	I <sub>1</sub> O = 20 (E <sub>1</sub> – E <sub>8</sub> )	-10.0	+10.0	nA
		3	6	я		3,4,5	"	E9	и	I <sub>O</sub> = 20 (E <sub>2</sub> – E <sub>9</sub> )	ä	"	и
		n	10	я		3,4,5	"	E10	и	I <sub>1</sub> O = 20 (E <sub>3</sub> – E <sub>10</sub> )	ä	"	и
	llO(R)	19	11	3		3,4,5,8,9,10	"	E11	"	I <sub>1</sub> O = 20 (E5 – E11)	-25.0	+25.0	и
	₽ F	и	12	ĸ		1,3,4,5	n	E12	и	+IIB = 20 (E1 – E12)	-100	+0.1	и
		з	13	3		1,3,4,5	n	E13	n	+IIB = 20 (E2 – E13)	-150	*	z
		3	41	3		1,3,4,5	n	E14	39	+IIB = 20 (E3 – E14)	-150	3	3
	-IB	и	15	ĸ		2,3,4,5	n	E15	и	-IIB = 20 (E15 – E1)	-100	"	и
		3	16	3		2,3,4,5	n	E16	39	-IIB = 20 (E16 – E2)	-150	3	3
		и	17	ĸ		2,3,4,5	n	E17	и	-IIB = 20 (E17 – E3)	-150	"	и
	VO(STB)	3	18			1,2,4,5,10	7	E18	39	VO(STB) = E18	+14.0		^
	VIO(ADJ)+	ä	19	-20.0 V		1,2,3,4,5,8,11	14	E19	3	VIO(ADJ)+= E1 – E19	+5.0		mV
	VIO(ADJ)-	3	20	-20.0 V		1,2,3,4,5,9,11	14	E20	ž.	VIO(ADJ)-= E1 – E20		-5.0	mV

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 - continued.  $\underline{1}/$ 

			12											
			7											
			10		GNĐ	"	"	"	"	"	"	"	"	"
			6											
			80		GND	n	n	n	n	n	n	n	n	n
-ì	numbers		7		8 mA	8 mA	50 mA	50 mA	+32.0 V					5.0 V
oenulluoo - G	Adapter PIN numbers		9											
ses o4 and o			2		GNÐ	GNÐ	-15.0 V	-15.0 V	-18.0 V	n	n	-15.0 V	n	"
Able   III. Group A inspection for device types 04 and 05 - continued.   1/			4	:3 – E2)]	+4.5 V	+4.5 V	+15.0	+15.0	+18.0 V	n	n	+15.0 V	n	n
A Inspection			е	.5 × 10 <sup>3</sup> / (E	+6.5 V	+9.0 V	+18.0 v	-9.0 V	-5 V			+10.0 V	+10.0 V	
E III. Group			2	Calculation = 20 log [27.5 $\times$ 10 <sup>3</sup> / (E <sub>3</sub> – E <sub>2</sub> )]	+0.5 V	+3.0 V	+13.0 V	-14.0 V	GND	-17.0 V	+12.0 V	GND	GND	+0.1 V
IABL			-	Calculation	+0.5 V	+3.0 V	+13.0 V	-14.0 V	GND	+12.0 V	-17.0 V	GND	"	"
	Test	no.		21	22	23	24	25	56	27	28	59	30	31
	MIL-STD	-883	method	4003	3007	n	n	n	3009	4001	4001	3002	3002	3011
	Symbol			CMRR	VOL1 2/	VOL2 <u>2</u> /	VOL3 2/	VOL4 <u>2</u> /	ICEX	111	ll2	HICC	20 -	/Ē SOI
	Subgroup			-	TA = +25°C	(figure 2)								
	<u> </u>			L										

See footnotes at end of device types 04 and 05.

υĄ

Ψ

+200

los = 131

31

1,2

31

3011

\<u>s</u> 30

Unit

>

Limits 40.4 +500 +500 Мах +0.4 +10 +80 -5.0 Μi -2 -5 7 VOL4 = E25 VOL2 = E23 VOL3 = E24 TABLE III. Group A inspection for device types 04 and 05 – continued.  $\underline{1/}$ VOL1 = E22 ICEX = 126 +ICC = 129 -ICC = 130 112 = 128 11 = 127 Unit Α υĄ Pin measured Value E23 E24 129 E22 128 126 127 130 . Š 7 energized Relays 1,2,12 1,2,12 1,2,12 1,2,12 1,2,12 1,2 1,2 4 Adapter pin 13 Test . 0 7 22 23 24 25 26 27 28 MIL-STD method -883 4003 3007 3009 3005 3005 4001 4001 VOL2 <u>2</u>/ VOL3 <u>2</u>/ VOL1 <u>2</u>/ VOL4 <u>2</u>/ Symbol CMRR 202 ICEX  $\frac{9}{2}$ Ξ 2

See footnotes at end of device types 04 and 05.

TA = +25°C

(figure 2)

Subgroup

TABLE III. Group A inspection for device types 04 and 05 - continued. 1/

		12	+20.0 V	3	3	3	3	3	79		+20.0 V	3	3	"		+20.0 V	3	3	3	3	39
		7	GND	+14.5 V	-13.0 V	GND	GND	+14.5 V	-13.0 V		GND	+14.5 V	-13.0 V	GND		GND	+14.5 V	-13.0 V	GND	+14.5 V	-13.0 V
		10																			
		6																			
		8	+15.0 V	+29.5 V	+2.0 V	+2.5 V	+15.0 V	+29.5 V	+2.0 V		+15.0 V	+29.5 V	+2.0 V	+15.0 V		+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V
numbers		7																			
Adapter PIN numbers		9					+15.0 V	+29.5 V	+2.0 V					+15.0 V							
		5	-15.0 V	-0.5 V	-28.0 V	-2.5 V	-15.0 V	-0.5 V	-28.0 V		-15.0 V	-0.5 V	-28.0 V	-15.0 V	4/	-15.0 V	-0.5 V	-28.0 V	-15.0 V	-0.5 V	-28.0 V
		4	+15.0 V	+29.5 V	+2.0 V	+2.5 V	+15.0 V	+29.5 V	+2.0 V	/100°C <u>4</u> /	+15.0 V	+29.5 V	+2.0 V	+15.0 V		+15.0 V	+29.5 V	+2.0 V	+15.0 V	+29.5 V	+2.0 V
		ю								Calculation = [VIO (E32) – VIO(E1)] / $100^{\circ}$ C $\frac{4}{2}$					Calculation = [IIO(test 40) – IIO(test 8)] / 100°C						
		2	GND	"	"	"	3	"	3	ı = [VIO (E32	GNĐ	3	"	"	ı = [IJO(test 4	GNĐ	"	3	"	"	"
		-	GND	"	"	"	"	"	79	Calculation	GNĐ	"	"	"	Calculation	GNĐ	"	"	"	"	"
Test	no.		32	33	34	32	36	28	38	68	40	41	42	43	44	45	46	47	48	49	9
MIL-STD	-883	method	4001	3	3	3	3	3	я	3	3	3	3	"	и	"	3	3	3	3	"
Symbol			ΟlΛ				VIO(R)			ΤΔ/ΟΙΛΔ	Oll			(B)OII	T∆\O \∆	8l <sub>l</sub> +			8II-		
Subgroup			2	TA = +125°C	(figure 2)																

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and  $\overline{05}$  – continued.  $\underline{1}/$ 

Viol.   Viol	alionodiiS	lodmyS	OTS-IIM	Text	Adanter pin	r nin	Relave		Pin measured		Forustion		- imit	
Maritod   Mari		ì												
VOOR         4001         32         14         No.         Value         Unit         Mon			-883	0	num	sers	energized							
VOO         4001         32         20.0 V         1,23,45         14         E29         V         VOO=E32         -4         +4         +4           V A CALL SA			method		13	14		No.	Value	Unit		Min	Мах	Unit
Note	2	ΟlΛ	4001	32	-20.0 V		1,2,3,4,5	14	E32	>	VIO = E32	-4	+4	mV
VOOR IDEA         **	TA = +125°C		29	33	*		1,2,3,4,5	,	E33	2	VIO = E33	*	"	n
1.2.3.4.5   3.   1.2.3.4.5.8.10   1.2.3.4.5.8.10   1.2.3.4.5.8.9.10   1.3.4.5.8.9.10   1.3.4.8.9.10	(figure 2)		29	34	*		1,2,3,4,5	,	E34	2	VIO = E34	*	"	n
"         36         "         1,2,3,4,5,8,9,10         "         E36         "         VIO(R) = E36         "4.5         #4.5           "         37         "         1,2,3,4,5,8,9,10         "         E37         "         VIO(R) = E36         "         "         "           "         38         "         1,2,3,4,5,8,9,10         "         E38         "         VIO(R) = E38         "         "         "         "           "         40         20.0 V         3,4,5         14         E40         V         IIO = 20 (E40 – E32)         "         "         "           "         41         "         5,4,5         "         E42         "         IIO = 20 (E40 – E32)         "         "           "         42         "         3,4,5,8,9,10         "         E42         "         IIO = 20 (E40 – E34)         "         "           "         43         "         3,4,5,8,9,10         "         E43         "         IIO = 20 (E40 – E34)         "         "           "         45         "         3,4,5,8,9,10         "         E43         "         IIIO = 20 (E40 – E35)         "         "           "         46 <td></td> <td></td> <td>n</td> <td>32</td> <td>3</td> <td></td> <td>1,2,3,4,5</td> <td>'n</td> <td>E35</td> <td>¥</td> <td>VIO = E35</td> <td>*</td> <td>"</td> <td>и</td>			n	32	3		1,2,3,4,5	'n	E35	¥	VIO = E35	*	"	и
"         37         "         E37         "         VO(R) = E37         "         "         "           "         38         "         1,2,34,5,8,9,10         "         E38         "         VO(R) = E38         "         "           "         39         ** <td></td> <td>VIO(R)</td> <td>u</td> <td>36</td> <td>3</td> <td></td> <td>1,2,3,4,5,8,9,10</td> <td>"</td> <td>E36</td> <td>n</td> <td>VIO(R) = E36</td> <td>-4.5</td> <td>+4.5</td> <td>и</td>		VIO(R)	u	36	3		1,2,3,4,5,8,9,10	"	E36	n	VIO(R) = E36	-4.5	+4.5	и
"         38         "         E38         "         VIO(R) = E38         "         VIO(R) = E38         "         "           "         38         "         E38         "         VIO(R) = E38         "         25.0         425.0         "           "         40         20.00 V         3.4.5         "         E41         "         IIO = 20 (E41 - E33)         "         110.0 <th< td=""><td></td><td></td><td>я</td><td>37</td><td>3</td><td></td><td>1,2,3,4,5,8,9,10</td><td>"</td><td>E37</td><td>n</td><td>VIO(R) = E37</td><td>×</td><td>n</td><td>и</td></th<>			я	37	3		1,2,3,4,5,8,9,10	"	E37	n	VIO(R) = E37	×	n	и
"         39         4.5         14         E40         V         IIO = 20 (E40 – E32)         -10.0         +25.0           "         41         "         3.4.5         "         E41         "         IIO = 20 (E41 – E32)         -10.0         +10.0           "         42         "         3.4.5         "         E42         "         IIO = 20 (E42 – E34)         "         "           "         43         "         3.4.5, 8.9.10         "         E42         "         IIO = 20 (E42 – E34)         "         "           "         43         "         3.4.5, 8.9.10         "         E43         "         IIO = 20 (E42 – E34)         "         "           "         45         "         E43         "         IIO = 20 (E42 – E34)         "         "         "         "           "         45         "         1.3.4.5         "         E45         "         HIB = 20 (E32 – E45)         "         "         1.00         "         1.00         "         "         "         "         1.00         "         1.00         "         "         "         "         1.00         "         1.00         "         "         "			3	38	3		1,2,3,4,5,8,9,10	3	E38	3	VIO(R) = E38	3	"	n
40   -20.0 V   3,4,5   14   E40   V   110 = 20 (E40 - E32)   -10.0   +10.0     41     3,4,5     E41     110 = 20 (E41 - E33)         42     3,4,5     E43     110 = 20 (E42 - E34)         43     3,4,5,8,9,10     E43     110 = 20 (E42 - E34)         45     3,4,5,8,9,10     E43     110 = 20 (E43 - E35)         45     45     45     E45     41B = 20 (E32 - E45)     4100   4.0.1     46     47     48     E46     41B = 20 (E32 - E45)     4.0.1     47     48     2,3,4,5     E48     41B = 20 (E49 - E32)     4.0.1     48     49     2,3,4,5     E49     41B = 20 (E49 - E32)     4.0.1     49     50     2,3,4,5     E50     41B = 20 (E50 - E34)     4.0.1     40     50     6.0     6.0     4.0.1     40     60     60     6.0     4.0.1     6.0       40     60     60     6.0     4.0.1     6.0     6.0       40     60     60     6.0     6.0     4.0.1     6.0     6.0       40     60     60     60     60     6.0     6.0     6.0     6.0     6.0       40     60     60     60     6.0		∆VIO/∆T 4/	ä	39								-25.0	+25.0	μV/°C
"         41         "         3.4.5         "         E41         "         IIO = 20 (E41 - E33)         "         "           "         42         "         3.4.5 8.9.10         "         E42         "         IIO = 20 (E42 - E34)         "         "           "         43         "         E42         "         IIO = 20 (E42 - E34)         "         1.00           "         44         *		Oll	u	40	-20.0 V		3,4,5	14	E40	^	IO = 20 (E40 – E32)	-10.0	+10.0	nA
"         42         "         3.4.5         "         E42         "         IIO=20 (E42-E34)         "         1.0=20 (E42-E34)         "         1.0=20 (E42-E34)         "         1.0=20			я	41	3		3,4,5	"	E41	n	IO = 20 (E41 – E33)	×	n	и
"         43         "         E43         "         IO(R) = 20(E43 - E35)         -25.0         +25.0           "         44          1,34,5         14         E45         V         +IIB = 20 (E32 - E45)         -100         +100           "         46         "         1,34,5         "         E46         "         +IIB = 20 (E32 - E45)         -150         "           "         47         "         E46         "         +IIB = 20 (E32 - E45)         -150         "           "         47         "         E46         "         +IIB = 20 (E34 - E47)         -150         "           "         48         "         2,3,4,5         "         E48         "         -IIB = 20 (E48 - E32)         -150         "           "         49         "         2,3,4,5         "         E49         "         -IIB = 20 (E49 - E32)         -150         "           "         50         "         2,3,4,5         E50         "         -IIB = 20 (E50 - E34)         -150         "			n	42	3		3,4,5	'n	E42	n	IIO = 20 (E42 – E34)	¥	"	и
"       44       1,3,4,5       14       E45       V       +IIB = 20 (E32 - E45)       -100       +100       +101         "       46       "       1,3,4,5       "       E46       "       +IIB = 20 (E32 - E45)       -150       "         "       47       "       E47       "       +IIB = 20 (E33 - E46)       -150       "         "       48       "       2,3,4,5       "       E48       "       -IIB = 20 (E48 - E32)       -100       "         "       49       "       2,3,4,5       E50       "       -IIB = 20 (E49 - E33)       -150       "		llO(R)	u	43	3		3,4,5,8,9,10	"	E43	n	IO(R) = 20(E43 – E35)	-25.0	+25.0	и
45   -20.0V   1,3,4,5   14   E45   V   +IIB = 20 (E32 - E45)   -100   +0.1     46   "		ΔΙΟ/ΔΤ <u>4</u> /	ä	44								-100	+100	pA/°C
"         46         "         1,3,4,5         "         E46         "         +IIB = 20 (E33 - E46)         -150         "           "         47         "         1,3,4,5         "         E47         "         +IIB = 20 (E34 - E47)         -150         "           "         48         "         E48         "         -IIB = 20 (E48 - E32)         -100         "           "         49         "         2,3,4,5         E49         "         -IIB = 20 (E49 - E33)         -150         "           "         50         "         2,3,4,5         E50         "         -IIB = 20 (E50 - E34)         -150         "		₽IIB	u	45	-20.0V		1,3,4,5	14	E45	^	+IIB = 20 (E32 – E45)	-100	+0.1	nA
"         47         "         +IIB = 20 (E34 - E47)         -150         "           "         48         "         2,3,4,5         "         E48         "         -IIB = 20 (E48 - E32)         -100         "           "         49         "         2,3,4,5         E49         "         -IIB = 20 (E49 - E33)         -150         "           "         50         "         2,3,4,5         E50         "         -IIB = 20 (E50 - E34)         -150         "			я	46	3		1,3,4,5	"	E46	n	+IIB = 20 (E33 – E46)	-150	n	и
"         48         "         2,3,4,5         "         -100         "         -100         "           "         49         "         2,3,4,5         E49         "         -11B = 20 (E49 - E33)         -150         "           "         50         "         2,3,4,5         E50         "         -11B = 20 (E50 - E34)         -150         "			,,	47	z		1,3,4,5	,	E47	,,	+IIB = 20 (E34 – E47)	-150	n	и
49         "         2,3,4,5         E49         " IlB = 20 (E49 - E33)         -150         "           50         "         2,3,4,5         E50         " IlB = 20 (E50 - E34)         -150         "		ª¦	я	48	3		2,3,4,5	"	E48	n	-I <sub>I</sub> B = 20 (E48 – E32)	-100	n	и
50 " 2,3,4,5 E50 " -1IB = 20 (E50 – E34) -150 "			я	49	3		2,3,4,5		E49	n	-I <sub>I</sub> B = 20 (E49 – E33)	-150	n	и
			3	90	z		2,3,4,5		E50	3	-I <sub>1</sub> B = 20 (E <sub>50</sub> – E <sub>34</sub> )	-150	ä	я

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 - continued.  $\underline{1}/$ 

		12												
		11												
		10			GND	"	"	"	"	"	"	"	"	3
		6												
		8	+15.0 V		GND	y	11	"	"	11	11	11	"	*
numbers		7			8 mA	8 mA	50 mA	50 mA	+32.0 V					+5.0 V
Adapter PIN numbers		6	-3 mA											
		5	-15.0 V		GND	GND	-15.0 V	-15.0 V	-18.0 V	"	"	-15.0 V	11	3
		4	+15.0 V	34 – E33)]	+4.5 V	+4.5 V	+15.0 V	+15.0 V	+18.0 V	**	**	+15.0 V	**	3
		3		Calculation = 20 log $[27.5 \times 10^3 / (E_{34} - E_{33})]$	+6.5 V	+9.0 V	+18.0 V	-9.0 V	-5 V			+10.0 V	+10.0 V	
		2	+15.0 V	ı = 20 log [27	+0.5 V	+3.0 V	+13.0 V	-14.0 V	GND	-17.0 V	+12.0 V	GNĐ	GND	+0.1 V
		1	GND	Calculation	+0.5 V	+3.0 V	+13.0 V	-14.0 V	GND	+12.0 V	-17.0 V	GND	и	3
Test	no.		51	52	53	54	22	56	57	58	69	09	61	62
MIL-STD	-883	method	4001	4003	3007	"	и	я	3009	4001	4001	3002	3005	3011
Symbol			VO(STB)	CMRR	VOL1 2/	VOL2 2/	VOL3 2/	VOL4 <u>2</u> /	ICEX	111	112	+ICC	-lcc	los <u>3</u> /
Subgroup			2	TA = +125°C	(figure 2)									

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and  $\overline{05}$  – continued.  $\overline{1}/$ 

	Limits		Unit	۸	dB	۱ ۸		,, 9	,, 9	O nA	ä	ä	) mA	ä	, ,
	Ë		Max			+0.4	+0.4	+1.5	+1.5	+500	"	n	+6.0		+150
			Min	+14	+80					-1	-5	9-		-5.0	
=	Equation			VO(STB) = E51		VOL1 = E53	VOL2 = E54	VOL3 = E55	VOL4 = E56	ICEX = I57	11 = 158	112 = 159	+ICC = 160	-ICC = 161	
	7		Unit	^		^	n	n	n	nA	n	n	mA	"	=
	Pin measured		Value	E51		E53	E54	E55	E56	157	158	159	09	161	9
	Ь		No.	2		2	n	n	n	2	1	2	4	5	7
	Relays	energized		1,2,4,5,10		1,2,12	1,2,12	1,2,12	1,2,12	1,2	1,2,12	1,2,12	1,2	1,2	1.2
	er pin	numbers	14												
	Adapter pin	шnu	13												
	Test	no.		51	52	53	54	22	99	22	58	69	09	61	62
	MIL-STD	-883	method	4001	4003	3007	n	n	n	3009	4001	4001	3002	3005	3011
	Symbol			VO(STB)	CMRR	√2 \	/5 Z√	√OL3 <u>2</u>	VOL4 <u>2</u> ∕	ICEX	Ш	711	22 +	20 -	/6 00
	Subgroup			2	TA = +125°C	(figure 2)									

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 - continued. 1/

Subgroup	Symbol	MIL-STD	Test						Adapter PIN numbers	numbers					
		-883	no.												
		method		-	2	ю	4	5	9	7	80	თ	10	1	12
ю	ΟlΛ	4001	63	GND	GND		+15.0 V	-15.0 V			+15.0 V			GND	+20.0 V
TA = -55°C		"	64	"	×		+29.5 V	-0.5 V			+29.5 V			+14.5 V	з
(figure 2)		"	99	"	×		+2.0 V	-28.0 V			+2.0 V			-13.0 V	з
		31	99	3	3		+2.5 V	-2.5 V			+2.5 V			GND	3
	VIO(R)	*	29	3	3		+15.0 V	-15.0 V	+15.0 V		+15.0 V			GND	3
		"	89	"	×		+29.5 V	-0.5 V	+29.5 V		+29.5 V			+14.5 V	з
		"	69	n	,,		+2.0 V	-28.0 V	+2.0 V		+2.0 V			-13.0 V	n
	AVIO/AT	"	02	Calculation	= [VIO (E63	Calculation = [VIO (E63) – VIO(E1)] / $80^{\circ}$ C	/80°C <u>4</u> /								
	Oll	"	71	GND	GND		+15.0 V	-15.0 V			+15.0 V			GND	+20.0 V
		"	72	n	,,		+29.5 V	-0.5 V			+29.5 V			+14.5 V	n
		"	73	n	,,		+2.0 V	-28.0 V			+2.0 V			-13.0 V	n
	lo(R)	"	74	n	"		+15.0 V	-15.0 V	+15.0 V		+15.0 V			GND	n
	ΔΙΟ/ΔΤ	"	75	Calculation	= [IIO(test 7	Calculation = [I <sub>1</sub> O(test 71) - I <sub>1</sub> O(test 8)] / $80^{\circ}$ C	8)] / 80°C <u>4</u> /								
	#IB	"	76	GND	GND		+15.0 V	-15.0 V			+15.0 V			GND	+20.0 V
		"	77	я	**		+29.5 V	-0.5 V			+29.5 V			+14.5 V	я
		"	78	n	"		+2.0 V	-28.0 V			+2.0 V			-13.0 V	я
	-liB	"	79	и	"		+15.0 V	-15.0 V			+15.0 V			GND	я
		"	80	n	"		+29.5 V	-0.5 V			+29.5 V			+14.5 V	я
		n	81	я	я		+2.0 V	-28.0 V			+2.0 V			-13.0 V	я

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 – continued.  $\underline{1}/$ 

14   No. Value   Unit   Min   Min   Max     1,2,3,4,5   14   E63   V   VIO = E64   1   1,2,3,4,5   1   E66   1   VIO = E66   1,2,3,4,5   1   E67   1,2,3,4,5   1   E73   1   E73   1   E73   1   E74   1   E74	D Test		Ada	pte	Adapter pin	Relays		Pin measured		Equation		Limits	
13   14   14   15.34.5   14   16.3   14   10.14   10.14   11.234.5   14   16.3   14   17.34.5   14   16.3   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   17.34.5   14   14   14   14   14   14   14   1	-883 u	_	90.	numbers	ers	energized							
1.2.3.45	method			13	14		No.	Value	Unit		Min	Max	Unit
1,2,3,4,5 " E64 " V/O = E64 " " " " " " " " " " " " " " " " " " "	4001 63	63		-20.0 V		1,2,3,4,5	14	E63	^	VIO = E63	-4	+4	Λm
1,2,3,4,5     E65     ViO=E66           1,2,3,4,5     E66     ViO=E66           1,2,3,4,5,8,9,10     E68     ViO(R)=E67         1,2,3,4,5,8,9,10     E68     ViO(R)=E69         1,2,3,4,5,8,9,10     E69     ViO(R)=E69         1,2,3,4,5,8,9,10     E77     ViO(R)=E69         3,4,5     E77     ViO(R)=E69         3,4,5     E77     ViO(R)=E69         3,4,5     E77     ViO(R)=E69         3,4,5     E77     ViO(R)=E69         1,3,4,5     E77     ViO(R)=20(E74-E67)         1,3,4,5     E78     ViO(R)=20(E64-E77)       1,3,4,5     E78     Vio(R)=20(E64-E77)       1,3,4,5     E78     Vio(R)=20(E64-E78)       1,3,4,5     E79     Vio(R)=20(E64-E78)       1,3,4,5     E79     Vio(R)=20(E64-E78)       1,3,4,5     E79     Vio(R)=20(E64-E78)       1,3,4,5     E79     Vio(R)=E69       1,3,4,5   .	64	64		ä		1,2,3,4,5	n	E64	n	VIO = E64	"	"	n
1,2,3,4,5,8,9,10	65	99		ä		1,2,3,4,5	n	E65	n	VIO = E65	"	"	n
1,2,3,4,5,8,9,10 " E67 " VIO(R) = E67 4,5 4,5 4,5 4,5 4,5 8,9,10 " E68 " VIO(R) = E68 " 25.0 4,5 6,8,9,10 " E69 " 25.0 4,5 6,9 10	99 "	99		3		1,2,3,4,5	¥	E66	п	VIO = E66	"	"	и
1,234,5,8,9,10	67	29		ä		1,2,3,4,5,8,9,10	n	E67	n	VIO(R) = E67	-4.5	+4.5	и
1,2,3,4,5,8,9,10		89		ä		1,2,3,4,5,8,9,10	n	E68	и	VIO(R) = E68	n	n	n
3.4.5	69 "	69		ä		1,2,3,4,5,8,9,10	n	E69	n	VIO(R) = E69	"	"	и
3.4.5	" 70	70									-25.0	+25.0	μV/°C
3.4.5 " E72 " IIO=20 (E72-E64) " " " " " " " 3.4.5.8.9.10 " E73 " " IIO=20 (E73-E65) " " " " " " " " " " " " " " " " " " "	71	71		-20.0 V		3,4,5	14	E71	>	IIO = 20 (E71 – E63)	-20.0	+20.0	nA
3.4.5 " E73 " IIO=20 (E73 – E65) " " " 60.0    1.3.4.5 8.9.10 " E74 " IIO(R) = 20(E74 – E67) -50.0    1.3.4.5   14   E76   V   +IIB = 20 (E64 – E77)    1.3.4.5   " E77 " +IIB = 20 (E64 – E77)    2.3.4.5   E80 " -IIB = 20 (E81 – E63)    2.3.4.5   E81 " -IIB = 20 (E81 – E65)    2.3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81 " -IIB = 20 (E81 – E65)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -IIB = 20 (E81 – E67)    3.4.5   E81   " -I	72	72		3		3,4,5	3	E72	3	IIO = 20 (E72 – E64)	79	3	z
3,4,5,8,9,10 " E74 " IIO(R) = 20(E74 – E67) -50.0 +50.0   1,3,4,5	" 73	73		z		3,4,5	3	E73	ä	IO = 20 (E73 – E65)	n	3	3
1,3,4,5	74	74		з		3,4,5,8,9,10	3	E74	z	IO(R) = 20(E74 - E67)	-50.0	+50.0	2
1,3,4,5	75	75									-200	+200	pA/°C
1,3,4,5	, 16	92		-20.0V		1,3,4,5	14	E76	>	+IIB = 20 (E63 – E76)	-150	+0.1	nA
1,3,4,5	77	77		z		1,3,4,5	3	E77	z	+IIB = 20 (E64 – E77)	-200	3	3
2,3,4,5	, 78	78		з		1,3,4,5	3	E78	3	+IIB = 20 (E65 – E78)	-200	z	2
2,3,4,5 E80 " -IIB = 20 (E80 – E64) -200 " 2,3,4,5 E81 " -IIB = 20 (E81 – E65) -200 "	, 29	79		з		2,3,4,5	3	E79	3	-I <sub>1</sub> B = 20 (E79 – E63)	-150	z	2
2,3,4,5 E81 " -lIB = 20 (E81 – E65) 000 "	. 80	80		3		2,3,4,5		E80	3	-I <sub>1</sub> B = 20 (E <sub>80</sub> – E <sub>64</sub> )	-200	3	z
	. 81	81		3		2,3,4,5		E81	3	-I <sub>1</sub> B = 20 (E <sub>81</sub> – E <sub>65</sub> )	-200	2	z

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 - continued.  $\overline{1/}$ 

				;			The state of the s			=					
Subgroup	Symbol	MIL-STD	Test						Adapter PIN numbers	numbers					
		-883	no.												
		method		-	2	3	4	5	9	7	80	6	10	11	12
3	VO(STB)	4001	82	GND	+15.0 V		+15.0 V	-15.0 V	-2 mA		+15.0 V				
TA = -55°C	CMRR	4003	83	Calculation	7 = 20 log [27	Calculation = 20 log [27.5 $\times$ 10 <sup>3</sup> / (E65 – E64)]	=65 – E64)]								
(figure 2)	VOL1 2/	3007	84	+0.5 V	+0.5 V	+6.5 V	+4.5 V	GND		8 mA	GND		GND		
	VOL2 2/	39	85	+3.0 V	+3.0 V	+9.0 V	+4.5 V	GND		8 mA	27		77		
	VOL3 2∕	"	98	+13.0 V	+13.0 V	+18.0 V	+15.0 V	-15.0 V		50 mA	"		**		
	VOL4 <u>2</u> /	"	87	-14.0 V	-14.0 V	-9.0 V	+15.0 V	-15.0 V		50 mA	"		11		
	111	4001	88	+12.0 V	-17.0 V		+18.0 V	-18.0 V			я		11		
	112	4001	88	-17.0 V	+12.0 V		+18.0 V	-18.0 V			29		79		
	+lcc	3002	06	GND	GND	+10.0 V	+15.0 V	-15.0 V			27		77		
	-lcc	3005	91	я	GND	+10.0 V	и	и			29		79		
	/€ SOI	3011	62	29	40.1 V		39	"		+5.0 V	"		39		

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and  $\overline{05}$  – continued.  $\underline{1}/$ 

Subgroup	Symbol	MIL-STD	Test	Adapt	Adapter pin	Relays		Pin measured	7.	Equation		Limits	
		-883	no.	шnu	numbers	energized							
		method		13	14		No.	Value	Unit		Min	Max	Unit
8	VO(STB)	4001	82			1,2,4,5,10	7	E82	^	VO(STB) = E82	+14		^
TA = -55°C	CMRR	4003	83								08+		dВ
(figure 2)	√2 L1 √2	3007	84			1,2,12	2	E84	۸	VOL1 = E84		+0.4	^
	VOL2 <u>2</u> /	"	85			1,2,12	n	E85	"	VOL2 = E85		+0.4	и
	VOL3 <u>2</u> /	u	86			1,2,12	и	E86	n	VOL3 = E86		+1.5	я
	VOL4 <u>2</u> /	"	87			1,2,12	n	E87	"	VOL4 = E87		+1.5	и
	III	4001	88			1,2,12	1	188	hn	11 = 188	-5	+200	nA
	lı2	4001	89			1,2,12	2	189	nA	112 = 189	-5	+200	nA
	+lcc	3005	90			1,2	4	190	mA	+ICC = 190		+7.0	mA
	-lcc	3005	91			1,2	5	191	3	-ICC = 191	-6.0		z
	los <u>3</u> /	3011	92			1,2	7	192	z	IOS = 192		+250	z

See footnotes at end of device types 04 and 05.

ABLE III. Group A inspection for device types 04 and 05 - continued. 1

			12	+20.0 V	n	"	n	n	n							
			11													
			10													
			6	GND	+10.0 V	-10.0 V	GND	+10.0 V	-10.0 V							
			80													
. 1/	numbers		7	+15.0 V	"	"	"	"	"		on figure 5.		on figure 5.		on figure 5.	
2 - continued	Adapter PIN numbers		9							c.	edures listed		edures listed		edures listed	
oes 04 and 08			2	-15.0 V	"	"	n	"	"	•pt TA = -55°	ons and proce		ons and proce		ons and proce	
IABLE III. Group A inspection for device types $04$ and $05$ - continued. $1/$			4	+15.0 V	"	"	п	и	и	ogroup 5 exce	These tests shall be performed using test conditions and procedures listed on figure 5.		These tests shall be performed using test conditions and procedures listed on figure 5.		These tests shall be performed using test conditions and procedures listed on figure 5.	
A inspection			က							limits as suk	formed usin		formed usin		formed usin	
E III. Group			2	GND	"	"	"	"	"	luations, and	s shall be per		s shall be per		s shall be per	
IABL			1	GND	"	"	n	n	n	onditions, eq	These tests		These tests		These tests	
	Test	no.		63	94	96	96	26	86	terminal o	102	103	104	105	106	107
	MIL-STD	-883	method	4004	n	3	я	"	"	Same tests,						
	Symbol			AVE(REF)	AVE+	-AVE	AVE(REF)	AVE+	AVE-	(Tests 99 – 101) Same tests, terminal conditions, equations, and limits as subgroup 5 except TA = -55°C.	tRHLC	tRLHC	tRHLC	tRLHC	tRHLC	tRLHC
	Subgroup			4	TA = +25°C	(figure 2)	2	TA = +125°C	(figure 2)	9	7	TA = +25°C	8	TA = +125°C	80	TA = -55°C

See footnotes at end of device types 04 and 05.

TABLE III. Group A inspection for device types 04 and 05 - continued. 1/

Subgroup		MIL-STD	Test	Adapter pin	er pin	Relays	В	Pin measured		Equation		Limits	
		-883	no.	numbers	oers	energized							
		method		13	14		No.	Value	Unit		Min	Мах	Unit
4	AVE(REF)	4004	93	-20.0 V		1,2,3,5,7	14	E93	۸				
TA = +25°C	AVE+	n	94	n		1,2,3,5,7	и	E94	и	AVE+= 10/(E94 - E93)	+10.0		V/m/V
(figure 2)	AVE-	ä	98	n		1,2,3,5,7	и	E95	и	AVE-= 10/(E93 – E95)	+10.0		ä
5	AVE(REF)	n	96	n		1,2,3,5,7	и	E96	и				
TA = +125°C	AVE+	ä	97	n		1,2,3,5,7	и	E97	и	AVE+= 10/(E97 – E96)	+8.0		ä
(figure 2)	AVE-	ä	98	3		1,2,3,5,7	"	E98	и	AVE-= 10/(E96 – E98)	+8.0		ä
9	(Tests 99 – 101)	) Same tests	, terminal	conditions,	equations,	(Tests 99 $-$ 101) Same tests, terminal conditions, equations, and limits as subgroup 5 except TA = -55°C	5 except T⊿	. = -55°C					
7	tRHLC		102									300	ns
TA = +25°C	tRLHC		103									300	2
8	tRHLC		104									200	2
TA = +125°C	tRLHC		105									640	z
8	tRHLC		106									300	и
TA = -55°C	tRLHC		107									300	3

1/ For devices marked with the "Q" certification mark, the parameters listed herein may be guaranteed if not tested to the limits specified herein in accordance with the manufacturer's QM plan.

2/ VOL1 and VOL2 use VID = -6 mV; VOL3, VOL4 use VID = -5 mV.

 $\overline{3}$  Maximum test duration shall be 10 ms.

Test numbers 39, 44, 70, and 75, which require read and record measurements plus a calculation, may be omitted except when subgroups 2 and 3 are being performed for group A sampling inspections and group C and D end points.

A Represents delta.

쁑 ₹. Ψ Ž ۲ Μ +500 +500 +750 -0.1 -5.0 7 90 Unit ¥ μ ž ٩ 쁑 +500 +750 +500 +750 +750 +0.4 -1.0 -4.0 -0.1 -5.0 Ξ -75 90 +IIB = 20 (E3 – E10) -IIB = 20 (E11 – E1) -IIB = 20 (E12 – E2) +IIB = 20 (E1 – E8) -IIB = 20 (E<sub>13</sub> – E<sub>3</sub>) +IIB = 20 (E2 - E9)  $IO = 20 (E_5 - E_1)$ E2) IIO = 20 (E7 - E3) VOL2 = E15 VOL1 = E14 VOL3 = E16 VOL4 = E17 ICEX = 11 +ICC = 12 -ICC = 13  $VIO = E_2$ VIO = E3 VIO = E4 = E1 Equation IIO = 20 (E6 -N<sub>O</sub> > 3 > ₹ Ψ Ψ E10 E12 E15 E16 E11 E2 E6 <u>В</u> 6 핀 Е3 Α E5 E7 8 to 9 Бi 10 3 9 FABLE III. Group A inspection for device types 06 and 07 Relays 2 7 3.2 mA 3.2 mA 25 mA 25 mA 18 V -13.4 V -13.4 V -13.4 V -1.4 V -13.4 V 10.6 V -1.4 V 10.6 V -1.4 V 10.6 V 10.6 V -1.4 V 2 Adapter PIN numbers -2.5 V -2.25 V -12 V -12 V -12 V 12 V -12 V -12 V 12 V 12 V 12 V 12 V 0 < 0 0 < 0 Calculation = 20 log  $[24 \times 10^3 / |E_3|]$ -2.25 V -2.5 V -27 V -27 V -18 V -15 V -15 V -15 V -15 V -15 V -15 V -3 \ -27 V -3 \ -3 \ -3 \ -27 V -27 V 2.5 V 27 V 15 V 27 V 27 V 15 V 27 V 15 V 15 V 2.5 V 3.5 V 27 V 15 V 27 V 27 V 15 V 27 V 27 V 18 V 15 V 15 V 15 V 15 V 4 4 Š. \_ 7 2 9 10 7 12 13 15 16 17 19 က ω 6 18 20 7 Symbol VOL2 VOL3 VOL4 VOL1 ICEX 0/ 무 ₽ 20+ 20 <u>\_</u> TA = +25°C Subgroup

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쁑 ¥. Ž ۲ Μ Μ +500 +500 +750 -2.0 -0.1 -4.5 90 Unit ž ٩ 쁑 ¥ Ψ Ψ +500 +750 +500 +750 +750 +0.4 -1.0 -7.0 -4.5 -0.1 Ξ -75 90 .E20) +IIB = 20 (E18 – E25) E27) -11B = 20 (E28 - E18)IIB = 20 (E29 – E19) +IIB = 20 (E19 - E26) IIO = 20 (E22 – E18) IO = 20 (E23 - E19) IO = 20 (E24 - E20)VOL3 = E33 VOL4 = E34 VIO = E18 VIO = E19 +ICC = 15 VIO = E20 VIO = E21 IIB = 20 (E30 – VOL1 = E31 ICEX = 14 -lcc = l6 +IJB = 20 (E20 -Equation VOL2 = I L > 3 > ₹ Ψ Ψ E18 E19 E23 E28 E29 E30 E20 E24 E25 E26 E32 E33 E34 E22 E27 E21 E31 4 TABLE III. Group A inspection for device types 06 and 07 – continued. 8 to 9 Бi 10 3 9 Relays 2 7 3.2 mA 3.2 mA 25 mA 25 mA 18 V -13.4 V -13.4 V -13.4 V -13.4 V -1.4 V 10.6 V -1.4 V 10.6 V -1.4 V 10.6 V -1.4 V 2 Adapter PIN numbers = 20  $\log [24 \times 10^3 / [E_{24} - E_{23}]]$ -2.5 V -2.25 V -12 V -12 V -12 V -12 V 12 V -12 V 12 V 12 V 12 V 12 V 0 < 0 0 < 0 -2.25 V -2.5 V -27 V -27 V -18 V -15 V -15 V -15 V -15 V -15 V -15 V -3 \ -27 V -3 \ -3 \ -3 \ -27 V -27 V 2.5 V 27 V 15 V 27 V 27 V 15 V 27 V 15 V 15 V Calculation : 2.25 V 3.5 V 2.5 V 27 V 15 V 27 V 27 V 15 V 27 V 27 V 18 V 15 V 15 V 15 V 15 V Test Š. 23 24 25 26 27 33 36 40 4 42 22 28 29 30 31 32 34 35 37 38 39 Symbol VOL2 VOL3 VOL4 VOL1 ICEX 9 무 ₽ 20+ 20 <u>\_</u> TA = +125°C (figure 2) Subgroup 7

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TABLE III. Group A inspection for device types 06 and 07 – continued. 1/

Subgroup Sym	Symbol	Test			Ada	Adapter PIN numbers	bers			Relays	Me	Measurement	ŧ	Equation		Limit 06			Limit 07	
		No.	1	2	ε	4	5	9	7	energized	Pin	Value	Unit		Min	Мах	Unit	Min	Мах	Unit
>	ΟIΛ	43	15 V	15 V	Λ 91-	Λ0	-1.4 V		7 V	3,4,5	10	E35	>	VIO = E35	-7.0	+7.0	νm	-2.0	+2.0	νm
TA = -55°C		44	27 V	27 V	-3 V	12 V	-13.4 V			я	"	E36	"	VIO = E36	"	и	79	"	"	"
(figure 3)		45	3 V	3 V	A 22-	-12 V	10.6 V			39	n	E37	¥	VIO = E37	"	3	"	,	"	3
		46	2.5 V	2.5 V	-2.5 V	-2.5 V	1.1 V			39	n	E38	¥	VIO = E38	"	3	"	,	"	3
=	임	47	15 V	15 V	۸ 91-	۸٥	-1.4 V			1,2,3,4,5	n	E39	*	IIO = 20 (E39 – E35)	-100	+100	nA	-75	+75	nA
	<u>I</u>	48	27 V	27 V	-3 V	12 V	-13.4 V			3	3	E40	3	IIO = 20 (E40 – E36)	3	3	3	3	3	3
	<u>I</u>	49	3 \	3 \	-27 V	-12 V	10.6 V			3	3	E41	3	IIO = 20 (E41 – E37)	3	3	3	3	3	3
7	HB +	90	15 V	15 V	۸ 91-	۸٥	-1.4 V			2,3,4,5	n	E42	*	+IJB = 20 (E35 – E42)	-0.1	+1000	"	-0.1	+1000	3
		51	27 V	27 V	۸ ٤-	12 V	-13.4 V			39	n	E43	*	+IIB = 20 (E36 – E43)	"	3	"	,	"	3
		52	3 V	3 V	A 22-	-12 V	10.6 V			"	n	E44	*	+IIB = 20 (E37 – E44)	n	и	n	и	n	,,
₹	-IB	53	15 V	15 V	V 21-	Λ0	-1.4 V			1,3,4,5	n	E45	,	-I <sub>1</sub> B = 20 (E45 – E35)	n	n	n	"	"	n
		54	27 V	27 V	A E-	12 V	-13.4 V			77	n	E46	,	-IIB = 20 (E46 – E36)	n	n	и	и	"	"
		22	3 V	3 V	-27 V	-12 V	10.6 V			77	n	E47	,	-IIB = 20 (E47 – E37)	n	n	и	и	"	"
CM	CMRR	99	Calculation	Calculation = 20 log [24 x	[24 × 10 <sup>3</sup> /	10 <sup>3</sup> / [E37 – E36]]									90		dB	90		dB
ν.	VOL1	57	3.5 V		-1 V	-1 V		3.2 mA	7 V	5	8 to 9	E48	>	VOL1 = E48		+0.6	>		+0.6	>
ν.	VOL2	58	2.25 V		-2.25 V	-2.25 V		3.2 mA	"	29	ä	E49	99	VOL2 = E49		+0.6	n		+0.6	,
۸C	VOL3	59	27 V		-3 V	12 V		25 mA	и	и	ä	E50	ņ	VOL3 = E50		+1.5			+1.5	ä
۸C	VOL4	09	3 V		-27 V	-12 V		25 mA	и	39	n	E51	ņ	VOL4 = E51		+1.5	и		+1.5	ä
Ŧ	+ICC	61	15 V		-15 V				3		-	71	HA A	+ICC = 17		+11.5	Ψ		+11.5	mA
7-	20	62	15 V		-15 V				ä		3	8	MA A	-ICC = 18	-6.0		μ	-6.0		mA

V/m/ V/m/ V/m/V Limit 07 Max +10 +10 +20 Ξ V/m/ V/m/ V/mV Unit Limit 06 Ξ +10 +2 +2 AV = 10 / (EC - E54)AV = 10 / (EA - E52)AV = 10 / (EB - E53)Equation Unit 3 > Measurement E52 EB E53 E54 TABLE III. Group A inspection for device types 06 and  $\overline{07}$  – continued.  $\overline{1/2}$ ΕA EC Pin 10 3 energized 3,4 3,4 3,4 7 -1.5 V -1.5 V -1.5 V 2 Adapter PIN numbers -15 V -15 V -15 V -15 V -15 V -15 V 15 V Test Š 63 64 9 Symbol ₹ TA = +125°C (figure 2) TA = -55°C (figure 2)  $TA = +25^{\circ}C$  (figure 2) Subgroup

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Unit us us Limits Мах 125 160 Min t1 = tRLHC Equation t2 = tRHLC Piit > us us Value Ю Σ 2 Measurement TABLE III. Group A inspection for device types 06 and  $\overline{07}$  – continued.  $\overline{1/}$ Counter pulse width Counter pulse width Pi œ 3,4 7 7 7 2 \ 2 \ > 0 2 \ > 0 2 mA 2 mA 2 mA 2 mA > 0 0 \ > 0 Adapter PIN numbers -5 \ 2 5 \ E0 ä , 1.4 V -15 V 15 V Test Š. 99 29 Change 5 mV OD Open k1 Close k2 Apply 5 mV OD Close k1 Symbol Release k31, k4 Apply 100 mV Apply 100 mV tr LHC Reset **t**RHLC 2 In O TA = +25°C (figure 6) Subgroup 6

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Unit us us Limits Мах 160 160 Min t3 = tRLHC Equation t4 = tRHLC Unit > us us Value Ю ಭ 4 Measurement TABLE III. Group A inspection for device types 06 and  $\overline{07}$  – continued.  $\overline{1/}$ Counter pulse width Counter pulse width Pi œ 3,4 7 7 7 2 \ > 0 2 \ > 0 2 mA 2 mA 2 mA 2 mA > 0 0 \ Adapter PIN numbers > 0 -5 \ 2 5 \ E0 E0 ä , 1.4 V -15 V -15 V 15 V 15 V Test Š. 89 69 Apply 5 mV OD Change 5 mV OD Open k1 Close k2 Close k1 Release k3, k4 Apply 100 mV Apply 100 mV tr LHC Reset **t**RHLC 2 In O TA = +125°C (figure 6) Subgroup 10

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TABLE III. Group A inspection for device types 06 and 07 - continued. 1/

	Unit							su					ns
Limits	Max							125					160
	Min												
Equation								t5 = tRLHC					t6 = tRHLC
	Unit	^						su					ns
ment	Value	E0						t5					t6
Measurement	Pin	8						Counter pulse width					Counter pulse width
Relays	energized	3,4				1	1	1	1	1	2	2	2
	7	Λ9	n	"	"	n	"	Λ0	۸ ۶	"	и	u	۸٥
	9	0 V	и	7	и	"	2 mA	2 mA	0 0	"	3	2 mA	2 mA
mbers	2	0 V	"	я	-5 V	ä	n n	3	3	5 V	3	3	я
Adapter PIN numbers	4			Е0	"	n	"	"	n	"	n n	3	и
Adapte	3	1.4 V	n	"	"	n	"	"	n	"	n n	3	и
	2	V 21-	"	"	"	n	n	"	n	"	n	u	n
	-	15 V	n	"	"	"	79	"	n	"	ä	3	ä
Test	o N						70						71
Symbol		ΟlΛ	Release k3, k4	OI/V	Apply 5 mV OD	Close k1	Apply 100 mV	tRLHC	Reset	Change 5 mV OD	Open k1 Close k2	Apply 100 mV	tRHLC
Subgroup		11	TA = -55°C	(figure 6)									

1/ For devices marked with the "Q" certification mark, the parameters listed herein may be guaranteed if not tested to the limits specified herein in accordance with the manufacturer's QM plan.

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TABLE IV. Group C end-point electrical parameters. (TA =  $+25^{\circ}$ C) 1/2/3

	Delta		±0.5 mV	±50 nA	±50 nA	I
Device type 07 ±VCC = ±15 V	Limits	Мах	+1 mV	+500 nA	+500 nA	
	Lin	Min	-1 mV	-0.1 nA	-0.1 nA	
(0.5	Delta		±1 mV	±50 nA	±50 nA	-
Device type 06 ±VCC = ±15 V	Limits	Мах	+4 mA	500 nA	500 nA	i
	Lin	Min	-4 mA	-0.1 nA	-0.1 nA	
nd 05 = -15 V	Delta		±0.5 mV	±12.5 nA	±12.5 nA	∓5 nA
Device types 04 and 05 +VCC = +15 V, -VCC = -15 V	Limits	Мах	43 mV	±0.1 nA	±0.1 nA	10 nA
Devic +VCC =	Lin	Min	-3 mV	-100 nA	-100 nA	-1
\\ 9-=	Delta		±0.5 mV	±7.5 μА	47.5 μА	-
Device type 02 +VCC = +12 V, -VCC = -6 V	Limits	Мах	+3.5 mV	75 µА	75 µА	-
= 33 <sub>0</sub> +	Lin	Min	-3.5 mV	О µА	9η 0	
id 03 : = -6 V	Delta		±0.5 mV	∓2 μА	+2 μА	i
Device types 01 and 03 +VCC = +12 V, -VCC = -6 V	Limits	Max	+2 mV	20 µA	20 µA	
Devic +VCC =	Lim	Min	-2 mV	Au 0	γri 0	
Test			ΟlΛ	HIB	8II-	ICEX 4/

1/ For device types 01, 02, and 03, V/O deltas and limits apply to tests 1 and 2 in table III. For device types 04 and 05, V/O deltas and limits apply to tests 1, 2, and 3 in table III. For device types 06 and 07, VIO deltas and limits apply to tests 1, 2, and 3 in table III.

2/ For device types 01, 02, and 03, +IJB deltas and limits apply to test 4 in table III. For device types 04 and 05, +IJB deltas and limits apply to tests 12, 13, and 14 in table III.

3/ For device types 01, 02, and 03, -llg deltas and limits apply to test 5 in table III. For device types 04 and 05, -llg deltas and limits apply to tests 15, 16, and 17 in table III. For device types 06 and 07, +IIB deltas and limits apply to tests 8, 9, and 10 in table III.

For device types 06 and 07, -IJB deltas and limits apply to tests 11, 12, and 13 in table III.

 $\underline{4}^{\prime}$  ICEX deltas and limits apply to test 26 in table III.

- 4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-PRF-38535.
- 4.4 <u>Technology Conformance inspection (TCI)</u>. Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).
  - 4.4.1 Group A inspection. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:
    - a. Tests shall be as specified in table II herein.
  - 4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of MIL-PRF-38535.
  - 4.4.3 Group C inspection. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:
    - a. End point electrical parameters shall be as specified in table II herein.
    - b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- 4.4.4 <u>Group D inspection</u>. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End point electrical parameters shall be as specified in table II herein.
  - 4.5 Methods of inspection. Methods of inspection shall be specified and as follows.
- 4.5.1 <u>Voltage and current</u>. All voltage values given, except the input offset voltage (or differential voltage) are referenced to the external zero reference level of the supply voltage. Currents given are conventional current and positive when flowing into the referenced terminal.
- 4.5.2 <u>Burn-in and life test cooldown procedure</u>. When devices are measured at +25°C following application of the steady state life or burn-in condition, they shall be cooled to within 10°C of their power stable condition at room temperature prior to removal of the bias.

#### 5. PACKAGING

5.1 <u>Packaging</u>. For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of material is to be performed by DoD personnel, these personnel need to contact the responsible packaging activity to ascertain requisite packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Department or Defense Agency, or within the Military Department's System Command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contracting the responsible packaging activity.

#### 6. NOTES

- 6.1 <u>Intended use.</u> Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.
  - 6.2 Acquisition requirements. Acquisition documents should specify the following:
    - a. Title, number, and date of the specification.
    - b. PIN and compliance identifier, if applicable (see 1.2).
    - c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
    - d. Requirements for certificate of compliance, if applicable.
    - e. Requirements for notification of change of product or process to acquiring activity in addition to notification of the qualifying activity, if applicable.
    - f. Requirements for failure analysis (including required test condition of MIL-STD-883, method 5003), corrective action and reporting of results, if applicable.
    - g. Requirements for product assurance options.
    - h. Requirements for special carriers, lead lengths, or lead forming, if applicable. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
    - i. Requirements for "JAN" marking.
    - j. Packaging requirements (see 5.1).
- 6.3 <u>Superseding information</u>. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

- 6.4 Qualification. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43128-3990.
- 6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-STD-1331 and as follows:
- 6.5.1 <u>Logic threshold voltage</u>. The approximate voltage at the output of the comparator at which the loading logic circuitry changes its digital state.
- 6.5.2 <u>Voltage gain</u>. The ratio of the change in output voltage to the change in voltage between the input terminals producing it with the dc output level in the vicinity of the logic threshold voltage (A<sub>V</sub>).
- 6.5.3 <u>Response time</u>. The interval between the application of an input step function and the time when the output crosses the logic threshold voltage. The input step drives the comparator from some initial, saturated input voltage to an input level just barely in excess of that required to bring the output from saturation to the logic threshold voltage. This excess is referred to as the voltage overdrive.
- 6.5.4 <u>Positive output level</u>. The dc output voltage in the positive direction with the input voltage equal to or greater than a minimum specified amount.
- 6.5.5 <u>Negative output level</u>. The dc output voltage in the negative direction with the input voltage equal to or greater than a minimum specified amount.
  - 6.5.6 Output sink current. The maximum negative current that can be delivered by the comparator (I<sub>OL</sub>).
- 6.5.7 Peak output current. The maximum current that may flow into the output load without causing damage to the comparator.
- 6.5.8 <u>Differential input voltage</u>. The difference between the two voltages applied to the input terminals of an amplifier. The difference is considered positive when the noninverting input is positive with respect to the inverting input and negative when the inverting input is positive with respect to the noninverting input (V<sub>ID</sub>).
  - 6.5.9 Strobe current. The current into the strobe terminal of an amplifier (ISTB).
  - 6.5.10 Output leakage current. The current into the output of an amplifier with the output at high level (I<sub>O</sub>).
  - 6.5.11 Ground leakage current. The current into the ground terminal of an amplifier with the output at high level (IG).
  - 6.5.12 Input leakage current. The current into the input terminal of an amplifier with the output at a specified voltage (I<sub>I</sub>).

- 6.6 <u>Logistic support</u>. Lead materials and finishes (see 3.4) are interchangeable. Unless otherwise specified, microcircuits acquired to Government logistic support should be acquired to device class B (see 1.2.2), and lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.
- 6.7 <u>Substitutability</u>. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device type	Generic-industry type
01	710
02	711
03	LM106
04	LM111
05	LH2111
06	LM119
07	LT119A

6.8 <u>Changes from previous issue</u>. Asterisks are not used in this revision to identify changes with respect to the previous issue, due to the extensiveness of the changes.

Custodians:

Army – CR

Navy - EC

Air Force – 11

 $\mathsf{NASA}-\mathsf{NA}$ 

DLA - CC

Review activities:

Army - MI, SM

Navy - AS, CG, MC, SH, TD

Air Force – 03, 19, 99

Preparing activity: DLA - CC

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